

MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Features

1/4-Inch Color CMOS NTSC/PAL Digital Image SOC with Overlay Processor

MT9V136 Data Sheet

For the latest data sheet, refer to Aptina's Web site: www.aptina.com

Features

- Low-power CMOS image sensor with integrated image flow processor (IFP) and video encoder
- 1/4-inch optical format, VGA resolution (640H x 480V)
- ±2.5% additional columns and rows to compensate for lens alignment tolerances
- Overlay generator for dynamic bitmap overlay
- Integrated video encoder for NTSC/PAL with overlay capability and 10-bit I-DAC
- · Integrated microcontroller for flexibility
- On-chip image flow processor performs sophisticated processing, such as color recovery and correction, sharpening, gamma, lens shading correction, on-the-fly defect correction, auto white balancing, and auto exposure
- Auto black level calibration
- 10-bit, on-chip analog-to-digital converter (ADC)
- Internal master clock generated by on-chip phaselocked loop (PLL)
- Two-wire serial programming interface
- Interface to low-cost Flash through SPI bus
- High-level host command interface
- Stand alone operation support
- Comprehensive tool support for overlay generation and lens correction setup
- Development system with DevWare
- Overlay generation and compilation tools

Applications

- Analog surveillance CCTV
- Surveillance network IP camera

See "Ordering Information" on page 3. See details of new features on page 3.

Table 1: Key Parameters

Parameter	Typical Value
Pixel size and type	5.6μm x 5.6μm active pinned-photodiode with high-sensitivity mode for low-light conditions
Sensor format	680H x 512V (includes ±2.5% of rows and columns for lens alignment)
NTSC output	720H x 480V
PAL output	720H x 576V
Imaging area	Total array size: 3.584mm x 2.688mm
Optical format	¼-inch
Frame rate	50/60 fields/sec
Sensor scan mode	Progressive scan
Color filter array	RGB standard Bayer
Shutter type	Electronic rolling shutter (ERS)
Automatic Functions	Exposure, white balance, black level offset correction, flicker avoidance, color saturation control, on-the-fly defect correction, aperture correction
Programmable Controls	Exposure, white balance, horizontal and vertical blanking, color, sharpness, gamma correction, lens shading correction, horizontal and vertical image flip, windowing, sampling rates, GPIO control

Key parameters are continued on next page.



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Applications

Table 2: Key Parameters (continued)

Parameter		Typical Value	
Overlay Support ¹		Utilizes SPI interface to load overlay data from external flash/EEPROM memory with the	
		following features:	
		•Overlay Size 360 x 480 pixel rendered into 720 x 480 pixel display format	
		•Up to four (4) overlays may be blended simultaneously	
		•Selectable readout: Rotating order user selected	
		Dynamic scenes by loading pre-rendered frames from external memory	
		•Palette of 32 colors out of 64,000	
		8 colors per bitmap Blend factor dynamically programmable for smooth transitions	
		•Fast Update rate of up to 30 fps	
		•Every bitmap object has independent x/y position	
		•Statistic Engine to calibrate optical alignment	
		•Number Generator	
Windowing		Programmable to any size	
Max analog gain		0.5–16x	
ADC		10-bit, on-chip	
Output interface		Analog composite video out, single-ended or differential; 8-, 10-bit parallel digital output	
Output data formats ¹		Digital: Raw Bayer 8-,10-bit, CCIR656, 565RGB, 555RGB, 444RGB	
		Parallel: 27 MB/s	
Data rate		NTSC: 60 fields/sec	
		PAL: 50 fields/sec	
Control interface		Two-wire I/F for register interface plus high-level command exchange. SPI port to interface	
		to external memory to load overlay data, register settings, or firmware extensions.	
Input clock for PLL		27 MHz	
SPI Clock Frequencies		4.5 - 9.0 - 18 MHz, programmable	
		Analog: 2.8V ±5%	
Supply voltage		Core: 1.8V ±5%	
		IO: 2.8V ±5%	
Power consumption		Full resolution at 60 fps: <350mW ²	
Package		48-pin Ceramic LCC, 11.43mm x 11.43mm, 0.8mm pitch	
Ambient temperature		Operating: –30°C to 70°C	
		Storage: -50°C to +150°C	
Dark Current		< 200e/s at 60°C with a gain of 1	
Fixed pattern noise	Column	< 2%	
	Row	< 2%	
Sensitivity		11.9 V/lux-s at 550nm	
Signal to noise ratio (S/N)		45dB	
Pixel dynamic range		74.6 dB	

Notes:

- 1. Graphical overlay is available only in CCIR656 output format.
- 2. Analog output enabled; parallel output disabled.



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Ordering Information

Ordering Information

Table 3: Available Part Numbers

Part Number	Description	
MT9V136C12STC	CLCC Production part number	
MT9V136C12STC ES	CLCC ES part number	
MT9V136D00STC K22BC1 ES	Die ES part number	
MT9V136D00STC K22BC1 ES	Die ES part number	
MT9V136C12STCD ES	Demo kit	
MT9V136C12STCH ES	Head Board	

New Features

Integrated Video Encoder for PAL/NTSC with Overlay Capability

- Composite analog output (NTSC/PAL)
- 8-bit parallel digital output ITU-R BT.656 format
- · Raw Bayer format

On-Chip Overlay Generator

- Static and dynamic overlay graphics with four overlay planes plus number plane
- Support for serial SPI memory up to 16 megabytes
- Number generator
- Overlay blending and x/y positioning
- Overlay position adjustment and statistics engine to calibrate overlay
- Overlay support utilizes SPI interface to load overlay data from external Serial Flash/EEPROM to support the following features:
 - Overlay size 360 x 480 pixel rendered into 720 x 480 pixel display format
 - Up to four overlays may be blended simultaneously
 - Selectable readout: rotating order user selected
 - Dynamic scenes by loading pre-rendered frames from external memory
 - Palette of 32 colors out of 64,000
 - Eight colors per bitmap
 - Blend factor dynamically programmable for smooth transitions
 - Fast update rate of up to 30 fps
 - Every bitmap object has independent x/y position
 - Statistics engine to calibrate optical alignment



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Table of Contents

Table of Contents

Features	1
Applications	1
Ordering Information	3
New Features	
Integrated Video Encoder for PAL/NTSC with Overlay Capability	3
On-Chip Overlay Generator	
General Description	
Architecture	
Internal Block Diagram	
System Block Diagram	
Crystal Usage	
Pin Descriptions and Assignments	
Pin Assignments	
SOC Description	
Detailed Architecture Overview	
Sensor Core	
Sensor Pixel Array	
Image Flow Processor	
Test Patterns	
NTSC/PAL Test Pattern Generation.	
CCIR-656 Format	
Black Level Subtraction and Digital Gain	
Positional Gain Adjustments (PGA)	
The Correction Function	
Color Interpolation	
Color Correction and Aperture Correction	
RGB to YUV Conversion.	
Color Kill	
YUV Color Filter	
YUV-to-RGB/YUV Conversion and Output Formatting	
Output Format and Timing	
YUV/RGB Data Ordering	
Uncompressed 10-Bit Bypass Output	
Readout Formats	
Output Formats	
Output Ports	
Usage Modes	29
External Signal Processing	
Device Configuration	
Auto-Configuration	
Flash Configuration Mode	
Host Configuration	
Power Sequence	
Supported SPI Devices	
Supported SPI Commands	
Host Command Interface	
Host Command Process Flow	
Command Flow	
Set Parallel Mode - Normal (Overlay i656)	37
Summary of Host Commands	37



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Table of Contents

Slave Two-Wire Serial Interface	
Protocol	
Start Condition	40
Data Transfer	
Slave Address/Data Direction Byte	41
Message Byte	41
Acknowledge Bit	41
No-Acknowledge Bit	41
Stop Condition	41
Typical Operation	42
Single READ from Random Location	42
Single READ from Current Location	42
Sequential READ, Start from Random Location	43
Sequential READ, Start from Current Location	43
Single Write to Random Location	
Sequential WRITE, Start at Random Location	
Overlay Capability	
Serial Memory Partition	
External Memory Speed Requirement	
Overlay Adjustment	
Overlay Character Generator	
Character Generator	
Character Generator Details	
Full Character Set for Overlay	
Modes and Timing	
Composite Video Output	
NTSC	
PAL	
Single-Ended and Differential Composite Output	
Parallel Output (DOUT)	53
Reset and Clocks.	
Reset	
Clocks	
Floating Inputs	
Output Data Ordering	
I/O Circuitry	
I/O Timing	
Digital Output	
Slew Rate	
Configuration Timing	
Electrical Specifications.	
Power Consumption, Operating Mode	
NTSC Signal Parameters	
Two-Wire Serial Bus Timing	
Spectral Characteristics	
Package and Die Dimensions	
Revision History	
100 100 10 10 10 10 10 10 10 10 10 10 10	



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor List of Figures

List of Figures

Figure 1:	Internal Block Diagram	
Figure 2:	System Block Diagram	.11
Figure 3:	Using a Crystal Instead of an External Oscillator	.12
Figure 4:	Pin Assignments	.15
Figure 5:	Sensor Core Block Diagram	.17
Figure 6:	Pixel Array Description	
Figure 7:	Image Capture Example	
Figure 8:	Sensor Pixel Array	
Figure 9:	Pixel Color Pattern Detail (top right corner)	
Figure 10:	Spatial Illustration of Image Readout	
Figure 11:	Color Pipeline	
Figure 12:	Color Bar Test Pattern	
Figure 13:	Color Bars	
Figure 14:	Gamma Correction Curve	
Figure 15:	Auto-Config Mode	
Figure 16:	Flash Mode	
Figure 17:	Host Mode with Flash	
Figure 18:	Host Mode	
Figure 19:	External Signal Processing Block Diagram	
Figure 20:	Power-Up Sequence – Configuration Options Flow Chart	.33
Figure 21:	Interface Structure	
Figure 22:	Single READ from Random Location	.42
Figure 23:	Single Read from Current Location	
Figure 24:	Sequential READ, Start from Random Location	
Figure 25:	Sequential READ, Start from Current Location	
Figure 26:	Single WRITE to Random Location.	
Figure 27:	Sequential WRITE, Start at Random Location	44
Figure 28:	Overlay Data Flow.	
Figure 29:	Memory Partitioning	
Figure 30:	Overlay Calibration	
Figure 31:	Internal Block Diagram Overlay	
Figure 32:	Example of Character Descriptor 0 Stored in ROM	50
Figure 33:	Full Character Set for Overlay	
Figure 34:	Single-Ended Termination	
Figure 35:	Differential Connection—Grounded Termination	52
Figure 36:	CCIR656 8-Bit Parallel Interface Format for 525/60 (625/50) Video Systems	
Figure 37:	Typical CCIR656 Vertical Blanking Intervals for 525/60 Video System	
Figure 38:	Typical CCIR656 Vertical Blanking Intervals for 625/50 Video System	55
Figure 39:	Primary Clock Relationships	
Figure 40:	Typical I/O Equivalent Circuits	
•	71 1	
Figure 41: Figure 42:	NTSC Block	
Figure 42. Figure 43:	Digital Output I/O Timing	
Figure 44: Figure 45:	Slew Rate Timing	
	Configuration Timing	
Figure 46:	Power Up Sequence	
Figure 47:	Power Down Sequence	
Figure 48:	Reset to SPI Access Delay	
Figure 49:	Reset to Serial Access Delay	
Figure 50:	Reset to AE/AWB Image	
Figure 51:	SPI Output Timing	
Figure 52:	Video Timing	
Figure 53:	Equivalent Pulse	
Figure 54:	V Pulse	
Figure 55:	Two-Wire Serial Bus Timing Parameters	
Figure 56:	Quantum Efficiency	.77



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor List of Figures



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor List of Tables

List of Tables

Table 1:	Key Parameters	
Table 2:	Key Parameters (continued)	2
Table 3:	Available Part Numbers	3
Table 4:	Pin Descriptions	.13
Table 5:	Reset/Default State of Interfaces	.15
Table 6:	EIA Color Bars (NTSC)	.23
Table 7:	EBU Color Bars (PAL)	.23
Table 8:	NTSC	.23
Table 9:	PAL	.24
Table 10:	YCbCr Output Data Ordering	.27
Table 11:	RGB Ordering in Default Mode	.27
Table 12:	2-Byte Bayer Format	.27
Table 13:	SPI Flash Devices	.34
Table 14:	SPI Commands Supported	.34
Table 15:	GPIO Bit Descriptions	.34
Table 16:	System Manager Commands	.37
Table 17:	Overlay Host Commands	.37
Table 18:	GPIO Host Commands	.38
Table 19:	Flash Manager Host Commands	.38
Table 20:	Sequencer Host Commands	.38
Table 21:	TX Manager Host Commands	.38
Table 22:	Two-Wire Interface ID Address Switching	.40
Table 23:	Transfer Time Estimate	.46
Table 24:	Character Generator Details	
Table 25:	Field, Vertical Blanking, EAV, and SAV States 525/60 Video System	.54
Table 26:	Field, Vertical Blanking, EAV, and SAV States for 625/50 Video System	
Table 27:	Output Data Ordering in DOUT RGB Mode	
Table 28:	Output Data Ordering in Sensor Stand-Alone Mode	
Table 29:	Parallel Digital Output I/O Timing	
Table 30:	Slew Rate for PIXCLK and DOUT	
Table 31:	Configuration Timing	
Table 32:	Power Up Sequence	
Table 33:	Power Down Sequence	
Table 34:	RESET_BAR Delay Parameters	
Table 35:	SPI Data Setup and Hold Timing.	
Table 36:	Absolute Maximum Ratings	
Table 37:	Electrical Characteristics and Operating Conditions	
Table 38:	Video DAC Electrical Characteristics–Single-Ended Mode	
Table 39:	Video DAC Electrical Characteristics–Differential Mode	
Table 40:	Digital I/O Parameters	
Table 41:	Power Consumption – Condition 1	
Table 42:	Power Consumption – Condition 2	
Table 43:	NTSC Signal Parameters	
Table 44:	Video Timing	
Table 45:	Equivalent Pulse	
Table 46:	V Pulse	
Table 47.	Two-Wire Serial Rus Characteristics	76



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor General Description

General Description

The Aptina TM MT9V136 is a VGA-format, single-chip CMOS active-pixel digital image sensor for surveillance applications. It captures high-quality color images at VGA resolution and outputs NTSC or PAL interlaced composite video.

The VGA CMOS image sensor features DigitalClarity®—Aptina's breakthrough low-noise CMOS imaging technology that achieves near-CCD image quality (based on signal-to-noise ratio and low-light sensitivity) while maintaining the inherent size, cost, low power, and integration advantages of Aptina's advanced active pixel CMOS process technology.

The MT9V136 is a complete camera-on-a-chip. It incorporates sophisticated camera functions on-chip and is programmable through a simple two-wire serial interface or by an attached SPI Flash memory that contains setup information that may be loaded automatically at startup.

The MT9V136 performs sophisticated processing functions including color recovery, color correction, sharpening, programmable gamma correction, auto black reference clamping, auto exposure, 50Hz/60Hz flicker avoidance, lens shading correction, auto white balance (AWB), and on-the-fly defect identification and correction.

The MT9V136 outputs interlaced-scan images at 30 or 25 fps, supporting both NTSC and PAL video formats. The image data can be output on one or two output ports:

- Composite analog video (single-ended and differential output support)
- Parallel 8-, 10-bit digital

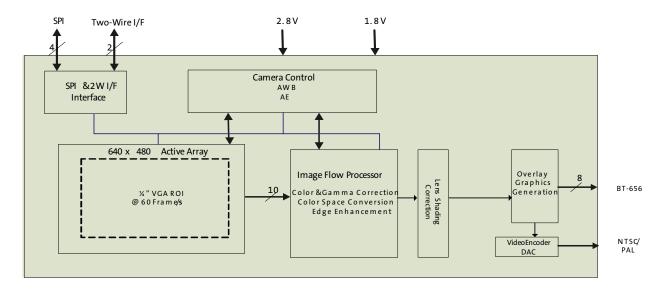


MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Architecture

Architecture

Internal Block Diagram

Figure 1: Internal Block Diagram



Note: The active array is smaller than the sensor array.

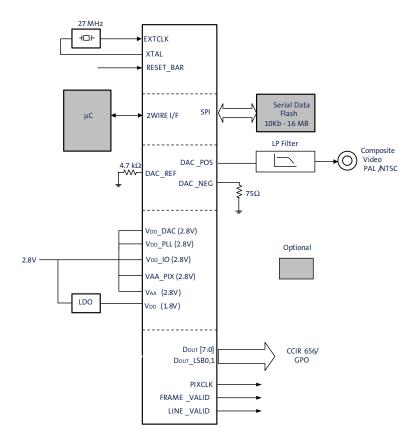


MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor System Block Diagram

System Block Diagram

The system block diagram will depend on the application. The system block diagram in Figure 2 shows all components; optional peripheral components are highlighted. The optional microcontroller controls the MT9V136 sensor using the two-wire serial bus. Optional components will vary by application. For further details, see the MT9V136 Register and Variable Reference.

Figure 2: System Block Diagram





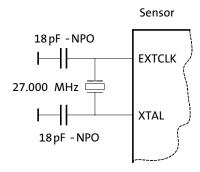
MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor System Block Diagram

Crystal Usage

As an alternative to using an external oscillator, a fundamental 27 MHz crystal may be connected between EXTCLK and XTAL. Two small loading capacitors of 15–33pF of NPO dielectric should be added as shown in Figure 3.

Aptina does not recommend using the crystal option for surveillance applications above 85°C. A crystal oscillator with temperature compensation is recommended.

Figure 3: Using a Crystal Instead of an External Oscillator





Pin Descriptions and Assignments

Table 4: Pin Descriptions

Pin Number	Pin Name	Туре	Description		
	Clock and Reset				
9	EXTCLK	Input	Master input clock (27MHz): This either can be a square-wave generated from an oscillator (in which case the XTAL input must be left unconnected) or connected directly to a crystal.		
10	XTAL	Output	If EXTCLK is connected to one pin of a crystal, this signal is connected to the other pin; otherwise this signal must be left unconnected.		
12	RESET_BAR	Input	Asynchronous active-low reset: When asserted, the device will return all interfaces to their reset state. When released, the device will initiate the boot sequence.		
			Register Interface		
17	SCLK	Input	These two signals implement serial communications protocol for access to the		
18	Sdata	Input/OD	internal register set and memory.		
16	SADDR	Input	This signal controls the device ID that will respond to serial communication commands. Two-wire serial interface device ID selection: 0: 0x90 1: 0xBA		
			SPI Interface		
22	SPI_SCLK	Output	Clock output for interfacing to an external SPI memory such as Flash/EEPROM. Tristated when RESET_BAR is asserted.		
21	SPI_SDI	Input	Data in from SPI device. This signal has an internal pull-up resistor.		
20	SPI_SDO	Output	Data out to SPI device. Tristated when RESET_BAR is asserted.		
19	SPI_CS_N	Output	Chip selects to SPI device. Tristated when RESET_BAR is asserted.		
			(Parallel) Pixel Data Output		
32	FRAME_VALID	Input/Output	Pixel data from the MT9V136 can be routed out on this interface and processed		
31	LINE_VALID	Input/Output	externally.		
33	PIXCLK	Output	To save power, these signals are driven to a constant logic level unless the parallel pixel data output or alternate (GPIO) function is enabled for these pins.		
39, 40, 41, 42,	Dout[7:0]	Output	This interface is disabled by default.		
43, 44, 45, 46			The slew rate of these outputs is programmable.		
			These signals can also be used as general purpose input/outputs.		
38	Dout_LSB1	Input/Output	When the sensor core is running in bypass mode, it will generate 10 bits of output		
37	Dout_LSB0	Input/Output	data per pixel. These two pins make the two LSB of pixel data available externally. Leave Dout_LSB1 unconnected if not used. To save power, these signals are driven to a constant logic level unless the sensor core is running in bypass mode or the alternate function is enabled for these pins. The slew rate of these outputs is programmable. For analog output, the Dout_LSBO cannot be left unconnected, and must be strapped to select either NTSC or PAL mode. For more information, see Table 15, "GPIO Bit Descriptions," on page 34.		
			Composite Video Output		
6	DAC_POS	Output	Positive video DAC output in differential mode. Video DAC output in single-ended mode. This interface is enabled by default using NTSC/PAL signalling. For applications where composite video output is not required, the video DAC can be placed in a power-down state under software control.		



Table 4: Pin Descriptions (continued)

Pin Number	Pin Name	Туре	Description	
4	DAC_NEG	Output	Negative video DAC output in differential mode. Connect to AGND in single-ende mode.	
2	DAC_REF	Output	External reference resistor for the video DAC.	
			Manufacturing Test Interface	
27	TDI	Input	JTAG Test pin (Reserved for Test Mode)	
26	TDO	Output	JTAG Test pin (Reserved for Test Mode)	
25	TMS	Input	JTAG Test pin (Reserved for Test Mode)	
24	TCK	Input	JTAG Test pin (Reserved for Test Mode)	
23	TRST_N	Input	Connect to GND	
			Power	
8, 14, 35, 48	DGND	Supply	Digital ground.	
3	GND_DAC	Supply	Video DAC GND	
1, 7, 15, 34	Vdd	Supply	Supply for VDD core: 1.8V nominal.	
13, 36, 47	VDD_IO	Supply	Supply for digital IOs: 2.8V nominal.	
5	Vdd_DAC	Supply	Supply for video DAC: 2.8V nominal.	
11	VDD_PLL	Supply	Supply for PLL: 2.8V nominal.	
29	Agnd	Supply	Analog ground.	
28	Vaa	Supply	Analog power: 2.8V nominal.	
30	VAA_PIX	Supply	Analog pixel array power: 2.8V nominal. Must be at same voltage potential as VAA.	



Pin Assignments

Figure 4: Pin Assignments

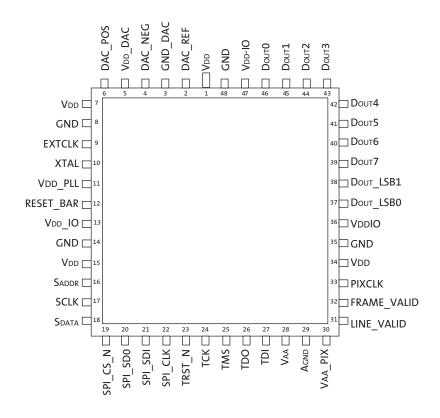


Table 5: Reset/Default State of Interfaces

Name	Reset State	Default State	Notes
EXTCLK	Clock running or stopped	Clock running	Input
XTAL	N/A	N/A	Input
RESET_BAR	Asserted	De-asserted	Input
SCLK	N/A	N/A	Input. Must always be driven to a valid logic level.
Sdata	High impedance	High impedance	Input/Output. A valid logic level should be established by pull-up resistor.
SADDR	N/A	N/A	Input. Must always be driven to a valid logic level. Must be permanently tied to VDD_IO or GND.
SPI_SCLK	High impedance.	Driven, logic 0	Output. Output enable is R0x0032[9].
SPI_SDI	Internal pull-up enabled.	Internal pull-up enabled	Input. Internal pull-up is permanently enabled.
SPI_SDO	High impedance	Driven, logic 0	Output enable is R0x0032[9].
SPI_CS_N	High impedance	Driven, logic 1	Output enable is R0x0032[9].



Table 5: Reset/Default State of Interfaces (continued)

Name	Reset State	Default State	Notes
FRAME_VALID LINE_VALID	High impedance	High impedance	Input/Output. This interface disabled by default. Input buffers (used for GPIO function) powered down by default, so these pins can be left unconnected (floating). After reset, these pins are powered up, sampled, then powered down again as part of the auto-configuration mechanism. See Note 2.
PIXCLK	High impedance	Driven, logic 0	Output. This interface disabled by default.
Dout7			See Note 1.
Д оит6			
Dоит5			
Dout4			
D оит3			
Dоит2			
Dout1			
Dоит 0			
Dout_LSB1	High impedance	High impedance	Input/Output. This interface disabled by default.
Dout_LSB0	High impedance	Driven, logic 0	Input buffers (used for GPIO function) powered down by default, so these pins can be left unconnected (floating). After reset, these pins are powered-up, sampled, then powered down again as part of the auto-configuration mechanism. For analog output, the DOUT_LSBO cannot be left unconnected, and must be strapped to select either NTSC or PAL mode.
DAC_POS	High impedance	Driven	Output. Interface disabled by hardware reset
DAC_NEG			and enabled by default when the device starts streaming.
DAC_REF			3
TDI	Internal pull-up enabled	Internal pull-up enabled	Input. Internal pull-up means that this pin can be left unconnected (floating).
TDO	High impedance	High impedance	Output. Driven only during appropriate parts of the JTAG shifter sequence.
TMS	Internal pull-up enabled	Internal pull-up enabled	Input. Internal pull-up means that this pin can be left unconnected (floating).
TCK	Internal pull-up enabled	Internal pull-up enabled	Input. Internal pull-up means that this pin can be left unconnected (floating).
TRST_N	N/A	N/A	Input. Must always be driven to a valid logic level. Must be driven to GND for normal operation.

Notes:

- 1. The reason for defining the default state as logic 0 rather than high impedance is this: when wired in a system (for example, on our demo boards), these outputs will be connected, and the inputs to which they are connected will want to see a valid logic level. No current drain should result from driving these to a valid logic level (unless there is a pull-up at the system level).
- 2. These pads have their input circuitry powered down, but they are not output-enabled. Therefore, they can be left floating but they will not drive a valid logic level to an attached device.



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor SOC Description

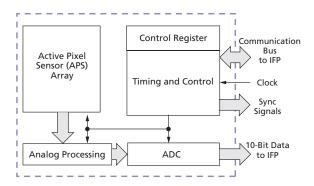
SOC Description

Detailed Architecture Overview

Sensor Core

The sensor consists of a pixel array, an analog readout chain, a 10-bit ADC with programmable gain and black offset, and timing and control as illustrated in Figure 5.

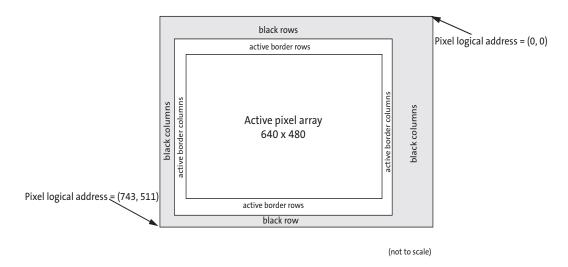
Figure 5: Sensor Core Block Diagram



Pixel Array Structure

The sensor core pixel array is configured as 744 columns by 512 rows, as shown in Figure 6. This includes black rows and columns.

Figure 6: Pixel Array Description



The black row data are used internally for the automatic black level adjustment. However, these black rows can also be read out by setting the sensor to raw data output mode.

There are 744 columns by 512 rows of optically-active pixels that include a pixel boundary around the VGA (640×480) image to avoid boundary effects during color interpolation and correction.

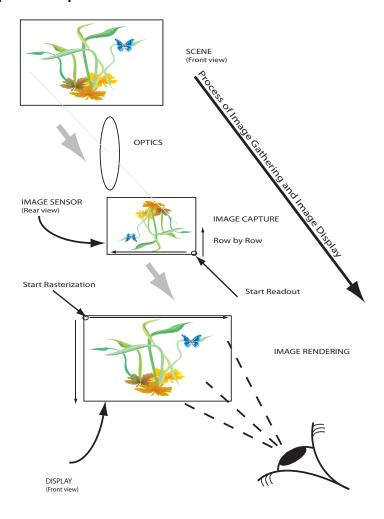


MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor SOC Description

The one additional active column and two additional active rows are used to enable horizontally and vertically mirrored readout to start on the same color pixel.

Figure 7 illustrates the process of capturing the image. The original scene is flipped and mirrored by the sensor optics. Sensor readout starts at the lower right corner. The image is presented in true orientation by the output display.

Figure 7: Image Capture Example



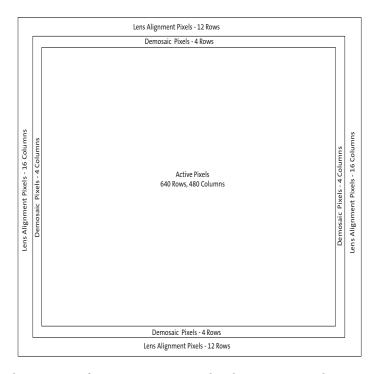


Sensor Pixel Array

The active pixel array is 640×480 pixels. In addition, there are rows and columns for lens alignment and demosaic.

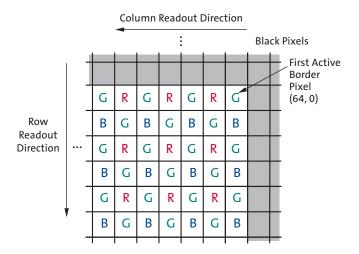
Not shown in Figure 8 are pixels for black level calibration.

Figure 8: Sensor Pixel Array



The range of adjustment is from Row 0 to 22 and Column 0 to 30. There are 4 rows/columns needed to calculate the RGB values. The window should be moved only at even numbers.

Figure 9: Pixel Color Pattern Detail (top right corner)





Output Data Format

The sensor core image data are read out in progressive scan order. Valid image data are surrounded by horizontal and vertical blanking, shown in Figure 10.

For NTSC output, the horizontal size is stretched from 640 to 720 pixels. The vertical size is 243 pixels per field; 240 image pixels and 3 dark pixels that are located at the bottom of the image field.

For PAL output, the horizontal size is also stretched from 640 to 720 pixels. The vertical size is 288 pixels per field.

Figure 10: Spatial Illustration of Image Readout

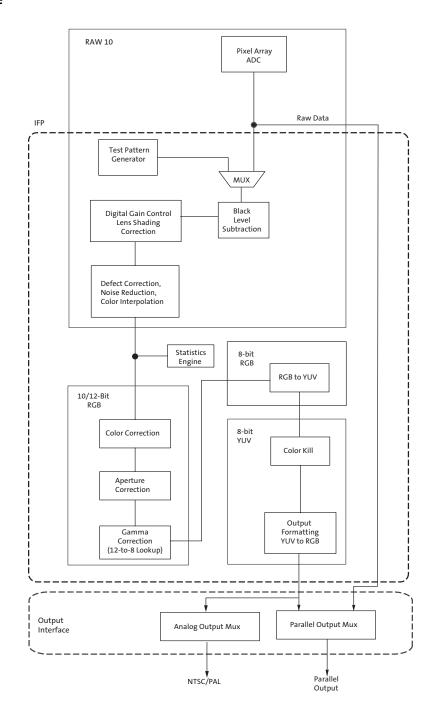
P _{0,0} P _{0,1} P _{0,2}	00 00 00 00 00 00 00 00 00 00 00 0
Valid Image Odd Field	Horizontal Blanking
P _{m-2,0} P _{m-2,1}	00 00 00 00 00 00 00 00 00 00 00 0
00 00 00 00 00 00 00 00 00 00 00 00	00 00 00 00 00 00 00 00 00 00 00 0
Vertical Even Blanking	Vertical/Horizontal Blanking
00 00 00 00 00 00 00 00 00 00 00 00	00 00 00 00 00 00 00 00 00 00 00 0
P _{1,0} P _{1,1} P _{1,2}	00 00 00 00 00 00 00 00 00 00 00 0
Valid Image Even Field	Horizontal Blanking
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	00 00 00 00 00 00 00 00 00 00 00 00
P _{m+1,0} P _{m+1,1} P _{m+1,n-1} P _{m+1,n} 00 00 00 00	00 00 00 00 00 00



Image Flow Processor

Image and color processing in the MT9V136 are implemented as an image flow processor (IFP) coded in hardware logic. During normal operation, the embedded microcontroller will automatically adjust the operation parameters. The IFP is broken down into different sections, as outlined in Figure 11.

Figure 11: Color Pipeline



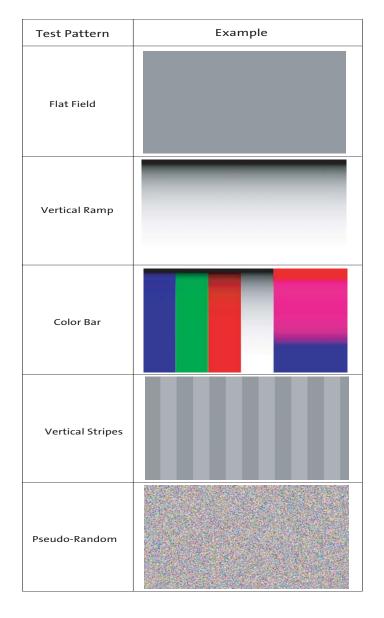


Test Patterns

During normal operation of the MT9V136, a stream of raw image data from the sensor core is continuously fed into the color pipeline. For test purposes, this stream can be replaced with a fixed image generated by a special test module in the pipeline. The module provides a selection of test patterns sufficient for basic testing of the pipeline.

Test patterns are accessible by programming a register and are shown in Figure 12. Aptina recommends disabling the MCU before enabling test patterns.

Figure 12: Color Bar Test Pattern





NTSC/PAL Test Pattern Generation

There is a built-in standard EIA (NTSC) and EBU (PAL) color bars to support hue and color saturation characterization. Each pattern consists of seven color bars (white, yellow, cyan, green, magenta, red, and blue). The Y, Cb and Cr values for each bar are detailed in Tables 6 and 7.

The test pattern is invoked through a Host Command call to the TX Manager. See the MT9V136 Host Command Specification.

Figure 13: Color Bars

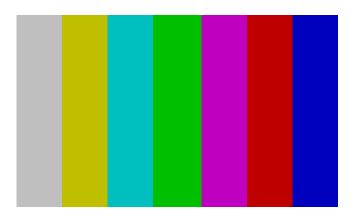


Table 6: EIA Color Bars (NTSC)

	Nominal Range	White	Yellow	Cyan	Green	Magenta	Red	Blue
Υ	16 to 235	180	162	131	112	84	65	35
Cb	16 to 240	128	44	156	72	184	100	212
Cr	16 to 240	128	142	44	58	198	212	114

Table 7: EBU Color Bars (PAL)

	Nominal Range	White	Yellow	Cyan	Green	Magenta	Red	Blue
Υ	16 to 235	235	162	131	112	84	65	35
Cb	16 to 240	128	44	156	72	184	100	212
Cr	16 to 240	128	142	44	58	198	212	114

CCIR-656 Format

The color bar data is encoded in 656 data streams. The duration of the blanking and active video periods of the generated 656 data are summarized in the following tables.

Table 8: NTSC

Line Numbers	Field	Description
1-3	2	Blanking
4-19	1	Blanking
20-263	1	Active video
264-265	1	Blanking
266-282	2	Blanking
283-525	2	Active Video



Table 9: PAL

Line Numbers	Field	Description
1-22	1	Blanking
23-310	1	Active video
311-312	1	Blanking
313-335	2	Blanking
336-623	2	Active video
624-625	2	Blanking

Black Level Subtraction and Digital Gain

Image stream processing starts with black level subtraction and multiplication of all pixel values by a programmable digital gain. Both operations can be independently set to separate values for each color channel (R, Gr, Gb, B). Independent color channel digital gain can be adjusted with registers. Independent color channel black level adjustments can also be made. If the black level subtraction produces a negative result for a particular pixel, the value of this pixel is set to 0.

Positional Gain Adjustments (PGA)

Lenses tend to produce images whose brightness is significantly attenuated near the edges. There are also other factors causing fixed pattern signal gradients in images captured by image sensors. The cumulative result of all these factors is known as image shading. The MT9V136 has an embedded shading correction module that can be programmed to counter the shading effects on each individual R, Gb, Gr, and B color signal.

The Correction Function

The correction functions can then be applied to each pixel value to equalize the response across the image as follows:

$$P_{corrected}(row,col) = P_{sensor}(row,col) *f(row,col)$$
 (EQ 1)

where *P* are the pixel values and *f* is the color dependent correction functions for each color channel.

Color Interpolation

In the raw data stream fed by the sensor core to the IFP, each pixel is represented by a 10-bit integer number, which can be considered proportional to the pixel's response to a one-color light stimulus, red, green, or blue, depending on the pixel's position under the color filter array. Initial data processing steps, up to and including the defect correction, preserve the one-color-per-pixel nature of the data stream, but after the defect correction it must be converted to a three-colors-per-pixel stream appropriate for standard color processing. The conversion is done by an edge-sensitive color interpolation module. The module pads the incomplete color information available for each pixel with information extracted from an appropriate set of neighboring pixels. The algorithm used to select this set and extract the information seeks the best compromise between preserving edges and filtering out high frequency noise in flat field areas. The edge threshold can be set through register settings.



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Sensor Pixel Array

Color Correction and Aperture Correction

To achieve good color fidelity of the IFP output, interpolated RGB values of all pixels are subjected to color correction. The IFP multiplies each vector of three pixel colors by a 3 x 3 color correction matrix. The three components of the resulting color vector are all sums of three 10-bit numbers. Since such sums can have up to 12 significant bits, the bit width of the image data stream is widened to 12 bits per color (36 bits per pixel). The color correction matrix can be either programmed by the user or automatically selected by the auto white balance (AWB) algorithm implemented in the IFP. Color correction should ideally produce output colors that are corrected for the spectral sensitivity and color crosstalk characteristics of the image sensor. The optimal values of the color correction matrix elements depend on those sensor characteristics and on the spectrum of light incident on the sensor. The color correction variables can be adjusted through register settings.

To increase image sharpness, a programmable 2D aperture correction (sharpening filter) is applied to color-corrected image data. The gain and threshold for 2D correction can be defined through register settings.

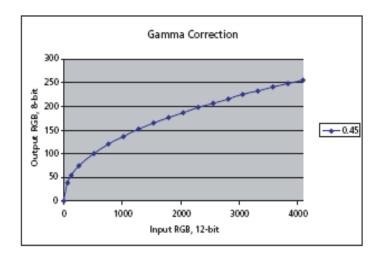


Gamma Correction

The MT9V136 IFP includes a block for gamma correction that can adjust its shape based on brightness to enhance the performance under certain lighting conditions. Two custom gamma correction tables may be uploaded corresponding to a brighter lighting condition and a darker lighting condition. At power-up, the IFP loads the two tables with default values. The final gamma correction table used depends on the brightness of the scene and takes the form of an interpolated version of the two tables.

The gamma correction curve (as shown in Figure 14) is implemented as a piecewise linear function with 19 knee points, taking 12-bit arguments and mapping them to 8-bit output. The abscissas of the knee points are fixed at 0, 64, 128, 256, 512, 768, 1024, 1280, 1536, 1792, 2048, 2304, 2560, 2816, 3072, 3328, 3584, 3840, and 4096. The 8-bit ordinates are programmable through IFP registers.

Figure 14: Gamma Correction Curve



RGB to YUV Conversion

For further processing, the data is converted from RGB color space to YUV color space.

Color Kill

To remove high-or low-light color artifacts, a color kill circuit is included. It affects only pixels whose luminance exceeds a certain preprogrammed threshold. The U and V values of those pixels are attenuated proportionally to the difference between their luminance and the threshold.

YUV Color Filter

As an optional processing step, noise suppression by one-dimensional low-pass filtering of Y and/or UV signals is possible. A 3- or 5-tap filter can be selected for each signal.



YUV-to-RGB/YUV Conversion and Output Formatting

The YUV data stream emerging from the scaling module can either exit the color pipeline as-is or be converted before exit to an alternative YUV or RGB data format.

Output Format and Timing

YUV/RGB Data Ordering

The MT9V136 supports swapping YCbCr mode, as illustrated in Table 10.

Table 10: YCbCr Output Data Ordering

Mode	Data Sequence				
Default (no swap)	Cb _i	Yi	Cr _i	Y _{i+1}	
Swapped CbCr	Cr _i	Yi	Cb _i	Y _{i+1}	
Swapped YC	Yi	Cb _i	Y _{i+1}	Cr _i	
Swapped CbCr, YC	Yi	Cr _i	Y _{i+1}	Cb _i	

The RGB output data ordering in default mode is shown in Table 11. The odd and even bytes are swapped when luma/chroma swap is enabled. R and B channels are bit-wise swapped when chroma swap is enabled.

Table 11: RGB Ordering in Default Mode

Mode (Swap Disabled)	Byte	D ₇ D ₆ D ₅ D ₄ D ₃ D ₂ D ₁ D ₀
565RGB	Odd	$R_7R_6R_5R_4R_3G_7G_6G_5$
	Even	$G_4G_3G_2B_7B_6B_5B_4B_3$
555RGB	Odd	$0 R_7 R_6 R_5 R_4 R_3 G_7 G_6$
	Even	$G_5G_4G_3B_7B_6B_5B_4B_3$
444xRGB	Odd	$R_7R_6R_5R_4G_7G_6G_5G_4$
	Even	B ₇ B ₆ B ₅ B ₄ 0 0 0 0
x444RGB	Odd	0 0 0 0 R ₇ R ₆ R ₅ R ₄
	Even	$G_7G_6G_5G_4B_7B_6B_5B_4$

Uncompressed 10-Bit Bypass Output

Raw 10-bit Bayer data from the sensor core can be output in bypass mode in two ways:

- Using 8 data output signals (DOUT[7:0]) and GPIO[1:0]. The GPIO signals are the least significant 2 bits of data.
- Using only 8 signals (DOUT[7:0]) and a special 8 + 2 data format, shown in Table 12.

Table 12: 2-Byte Bayer Format

Byte	Bits Used	Bit Sequence
Odd bytes	8 data bits	$D_9D_8D_7D_6D_5D_4D_3D_2$
Even bytes	2 data bits + 6 unused bits	00000D ₁ D ₀

Readout Formats

Progressive format is used for raw Bayer output.



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Sensor Pixel Array

Output Formats

ITU-R BT.656 and RGB Output

The MT9V136 can output processed video as a standard ITU-R BT.656 (CCIR656) stream, an RGB stream, or as unprocessed Bayer data. The ITU-R BT.656 stream contains YCbCr 4:2:2 data with fixed embedded synchronization codes. This output is typically suitable for subsequent display by standard video equipment or JPEG/MPEG compression.

Colorpipe data (pre-lens correction and overlay) can also be output in YCbCr 4:2:2 and a variety of RGB formats in 640 by 480 progressive format in conjunction with LINE VALID and FRAME VALID.

The MT9V136 can be configured to output 16-bit RGB (565RGB), 15-bit RGB (555RGB), and two types of 12-bit RGB (444RGB). Refer to Table 27 and Table 28 on page 57 for details.

Bayer Output

Unprocessed Bayer data are generated when bypassing the IFP completely—that is, by simply outputting the sensor Bayer stream as usual, using FRAME_VALID, LINE_VALID, and PIXCLK to time the data. This mode is called sensor stand-alone mode.

Output Ports

Composite Video Output

The composite video output DAC is external-resistor-programmable and supports both single-ended and differential output. The DAC is driven by the on-chip video encoder output.

Parallel Output

Parallel output uses either 8-bit or 10-bit output. Eight-bit output is used for ITU-R BT.656 and RGB output. Ten-bit output is used for raw Bayer output.



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Usage Modes

Usage Modes

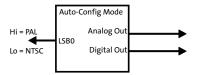
How a camera based on the MT9V136 will be configured depends on what features are used. In the simplest case, only an MT9V136 plus an external flash memory, or an 8-bit microcontroller (μ C) might be sufficient. Flash sizes vary depending on the data for registers, firmware, and overlay data—somewhere between 10Kb to 16MB. The two-wire bus is adequate since only high-level commands are used to invoke overlays, load registers from memory, or set up lens correction parameters. Overlay data can alternatively be issued by the external μ C if the rate of refreshing data is deemed adequate. If there are no commands in the Flash image the device can be in auto configuration mode by which the sensor is set up according to the status of pins FRAME_VALID, LINE_VALID and DOUT_LSB0. For further information, see "Auto-Configuration" on page 32.

In the simplest case no Flash memory or μC is required, as shown in Figure 15. This is truly a single chip operation.

Note:

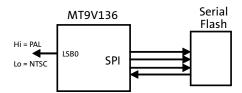
Because mandatory patches must be loaded, the Auto-Config mode is not recommended.

Figure 15: Auto-Config Mode



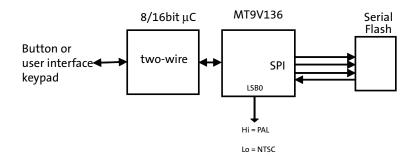
The MT9V136 can be configured by a serial Flash through the SPI Interface.

Figure 16: Flash Mode



In some applications, button or user interface keypad can trigger overlay images being called by the μC as shown in Figure 17.

Figure 17: Host Mode with Flash

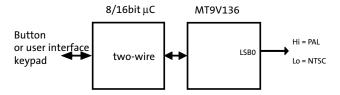




MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Usage Modes

Overlay information may also be passed by the μ C without a need for a Flash memory. However, because the data transfer rate is limited over the two-wire serial bus, the update rate may be slower. However, if overlay images are preloaded into the four onchip buffers, they may be turned on and off or move location at the frame rate as shown in Figure 18.

Figure 18: Host Mode



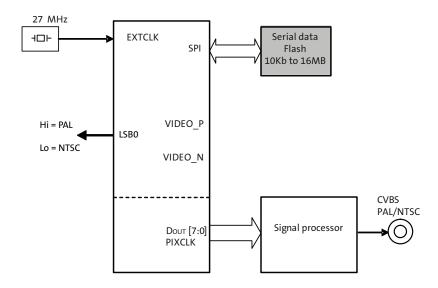


MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor External Signal Processing

External Signal Processing

An external signal processor can take data from ITU656 or raw Bayer output format and post-process or compress the data in various formats.

Figure 19: External Signal Processing Block Diagram



Device Configuration

After power is applied and the device is out of reset by de-asserting the RESET_BAR pin, it will enter a boot sequence to configure its operating mode. There are essentially four modes, two when Flash is present and two when Flash is not present. Figure 20: "Power-Up Sequence – Configuration Options Flow Chart," on page 33 contains more details on the configuration options.

If Flash is present and:

- A valid Flash device identifier is detected AND the Flash device contains valid configuration records, then
 - Disable Auto-Config
 - Parse Flash Content
 - Load Flash Configuration ->Flash Configuration Mode
- A valid Flash device identifier is detected BUT the Flash device DOES NOT contain valid configuration records, then
 - Enter Auto Configuration.

If Flash is not present and:

- SPI SDI == 0, then
 - Enter Host Configuration.
- SPI_SDI != 0, then
 - Enter Auto Configuration



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor External Signal Processing

Auto-Configuration

The device supports an auto-configuration feature. During system start-up, the device first detects whether an SPI Flash device is attached to the MT9V136. If not, it will then sample the state of a number of GPI inputs including FRAME_VALID, LINE_VALID and DOUT_LSB0. For more information, see Table 15, "GPIO Bit Descriptions," on page 34. The state of these inputs then determines the configuration of a number of subsystems of the device such as readout mode, pedestal and video format, respectively.

The auto-configuration feature can be disabled by grounding the SPI_DIN pin. The device samples the state of this pin during the Flash device detection process. If no SPI Flash device is detected (read device ID of 0x00 or 0xFF), OR the SPI_DIN pin is grounded, then auto-configuration is disabled.

Flash Configuration Mode

If a valid Flash is detected (by reading device ID other than 0x00 or 0xFF) and the flash device contains valid configuration records, then these configuration records are processed.

Host Configuration

This mode is entered if the SPI_DIN pin is grounded. The SOC performs no configuration, and remains idle waiting for configuration and instruction from the host.



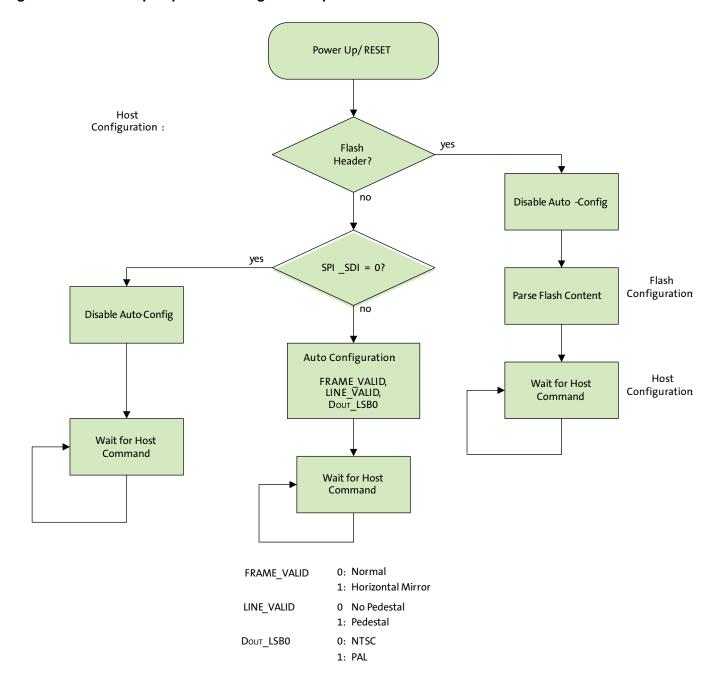
MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor External Signal Processing

Power Sequence

In power-up, the core voltage (1.8V) must trail the IO (2.8V) by a positive number. All 2.8V rails can be turned on at the same time or follow the power-up sequence in Figure 46: "Power Up Sequence," on page 63.

In power down, the sequence is reversed. The core voltage (1.8V) must be turned off before any 2.8V. Refer to Figure 47: "Power Down Sequence," on page 64 for details.

Figure 20: Power-Up Sequence – Configuration Options Flow Chart





MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor External Signal Processing

Supported SPI Devices

Table 13 lists supported Flash devices. Devices not compatible will require a firmware patch. Contact Aptina for additional support.

Table 13: SPI Flash Devices

Туре	Density	Manufacturer	Device	Speed (MHz)	Standard	Temp Range (°F)	Supported
Flash	8 MB	Atmel	AT26DF081A	70	JEDEC/Device ID	−20 to +85	Yes
Flash	1 MB	ST	M25P10-AVMB3	50		-40 to +125	Yes

Supported SPI Commands

The SPI commands shown in Table 14 are supported by the MT9V136.

Table 14: SPI Commands Supported

Command	Value
Read Array	0x03
Block Erase	0xD8
Chip Erase	0xC7
Read Status	0x05
Write status	0x01
Byte Page Program	0x02
Write Enable	0x06
Write Disable	0x04
Read Manufacturer and Device ID	0x9F
(Fast) Read Array	0x0B

Table 15: GPIO Bit Descriptions

	GPI[2] (DOUT_LSB0)	GPI[1] (FRAME_VALID)	GPI[0] (LINE_VALID)
Low ("0")	NTSC	Normal	No pedestal
High ("1")	PAL	Horizontal mirror	Pedestal



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor External Signal Processing

Host Command Interface

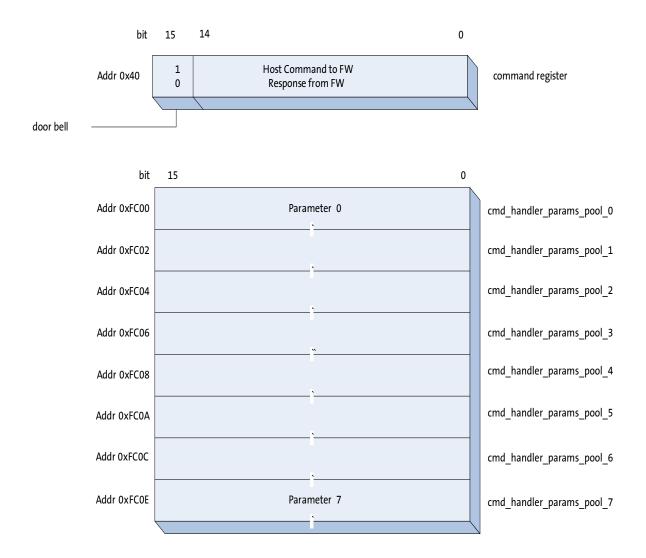
Aptina's sensors and SOCs contain numerous registers that are accessed through a two-wire interface with speeds up to 400 kHz.

The MT9V136, in addition to writing or reading straight to/from registers or firmware variables, has a mechanism to write higher level commands, the Host Command Interface (HCI). Once a command has been written through the HCI, it will be executed by on chip firmware and the results are reported back. In general, registers shall not be accessed with the exception of registers that are marked for "User Access."

Flash memory is also available to store commands for later execution. Under DMA control, a command is written into the SOC and executed.

For a complete spec on host commands, refer to the MT9V136 Host Command Interface Specification.

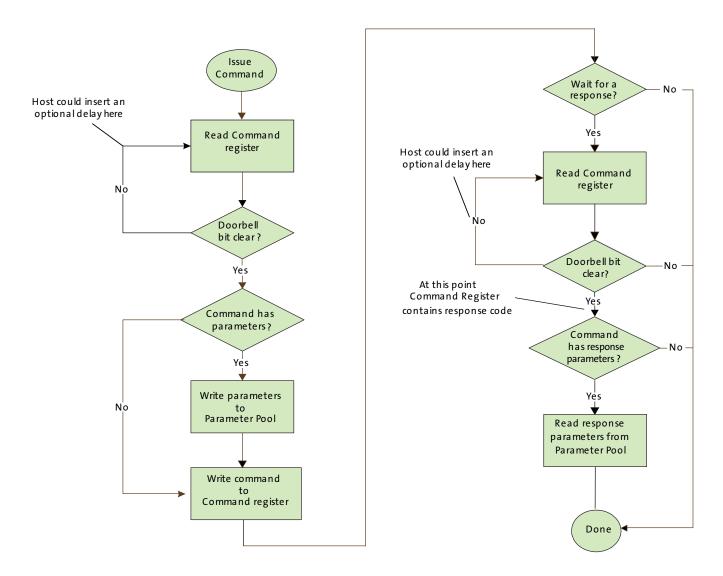
Figure 21: Interface Structure





MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor External Signal Processing

Host Command Process Flow



Command Flow

The host issues a command by writing (through a two-wire interface bus) to the command register. All commands are encoded with bit 15 set, which automatically generates the host command (doorbell) interrupt to the microprocessor.

Assuming initial conditions, the host first writes the command parameters (if any) to the parameters pool (in the command handler's logical page), then writes the command to command register. The interrupt handler then signals the command handler task to process the command.

If the host wishes to determine the outcome of the command, it must poll the command register waiting for the doorbell bit to be cleared. This indicates that the firmware completed processing the command. The contents of the command register indicate the command's result status. If the command generated response parameters, the host can now retrieve these from the parameters pool.



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor External Signal Processing

Note:

The host must not write to the parameters pool, nor issue another command, until the previous command completes. This is true even if the host does not care about the result of the previous command. Therefore, the host must always poll the command register to determine the state of the doorbell bit, and ensure the bit is cleared before issuing a command.

For a complete command list and further information consult the Host Command Interface Specification.

An example of how (using DevWare) a command may be initiated in the form of a "Preset" follows.

Set Parallel Mode - Normal (Overlay i656)

All DevWare presets supplied by Aptina poll and test the doorbell bit after issuing the command. Therefore there is no need to check if the doorbell bit is clear before issuing the next command.

```
REG= 0xFC00, 0x1000 // CMD_HANDLER_PARAMS_POOL_0
REG= 0x0040, 0x8801 // issue command
// POLL COMMAND_REGISTER::DOORBELL => 0x0
```

Summary of Host Commands

Table 16 on page 37 through Table 21 on page 38 show summaries of the host commands. The commands are divided into the following sections:

- System Manager
- Overlay
- GPIO Host interface
- Flash Manager Host
- Patch Loader Interface
- TX Manager

Following is a summary of the Host Interface commands. The description gives a quick orientation. The "Type" column shows if it is an asynchronous or synchronous command. For a complete list of all commands including parameters, consult the Host Command Interface Specification document.

Table 16: System Manager Commands

System Manager Host Command	Value	Type Description	
Set State	0x8100	Asynchronous	Request the system enter a new state
Get State	0x8101	Synchronous	Get the current state of the system

Table 17: Overlay Host Commands

Overlay Host Command	Value	Туре	Description	
Enable Overlay	0x8200	Synchronous Enable or disable the overlay subsystem		
Get Overlay State	0x8201	Synchronous	Synchronous Retrieve the state of the overlay subsystem	
Set Calibration	0x8202	Synchronous	nchronous Set the calibration offset	
Set Bitmap Property	0x8203	Synchronous Set a property of a bitmap		
Get Bitmap Property	0x8204	Synchronous	Get a property of a bitmap	
Set String Property	0x8205	Synchronous	nchronous Set a property of a character string	



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor External Signal Processing

Table 17: Overlay Host Commands

Overlay Host Command	Value	Туре	Description	
Load Buffer	0x8206	Asynchronous Load an overlay buffer with a bitmap (from Flash)		
Load Status	0x8207	Synchronous	Retrieve status of an active load buffer operation	
Write Buffer	0x8208	Synchronous	Write directly to an overlay buffer	
Read Buffer	0x8209	Synchronous	Read directly from an overlay buffer	
Enable Layer	0x820A	Synchronous	Enable or disable an overlay layer	
Get Layer Status	0x820B	Synchronous	Retrieve the status of an overlay layer	
Set String	0x820C	Synchronous	Set the character string	
Load String	0x820E	Asynchronous	Load a character string (from Flash)	

Table 18: GPIO Host Commands

GPIO Host Command	Value	Туре	Description	
Set GPIO Property	0x8400	Synchronous	Set a property of one or more GPIO pins	
Get GPIO Property	0x8401	Synchronous	Retrieve a property of a GPIO pin	
Set GPO State	0x8402	Synchronous	Set the state of a GPO pin or pins	
Get GPIO State	0x8403	Synchronous	Get the state of a GPI pin or pins	
Set GPI Association	0x8404	Synchronous	Associate a GPI pin state with a Command Sequence stored in SPI Flash	

Table 19: Flash Manager Host Commands

Flash Manager Host Command	Value	Туре	Description	
Get Lock	0x8500	Asynchronous	Request the Flash Manager access lock	
Lock Status	0x8501	Synchronous	Retrieve the status of the access lock request	
Release Lock	0x8502	Synchronous	Release the Flash Manager access lock	
Config	0x8503	Synchronous	Configure the Flash Manager and underlying SPI Flash subsystem	
Read	0x8504	Asynchronous	Read data from the SPI Flash	
Write	0x8505	Asynchronous	Write data to the SPI Flash	
Erase Block	0x8506	Asynchronous	Erase a block of data from the SPI Flash	
Erase Device	0x8507	Asynchronous	Erase the SPI Flash device	
Query Device	0x8508	Asynchronous	Query device-specific information	
Status	0x8509	Synchronous	Obtain status of current asynchronous operation	

Table 20: Sequencer Host Commands

Sequencer Host Command	Value	Туре	Description	
Set Encoding Mode	0x8603	Synchronous	Set the encoding mode	
Enable Horizontal Flip	0x8604	Synchronous	ıs Enable or disable horizontal flip	
Set Flicker Frequency	0x8605	Synchronous	Set the flicker frequency	
Refresh Mode	0x8606	Synchronous	Refresh the Sequencer mode/context	

Table 21: TX Manager Host Commands

TX Manager Host Command	Value	Туре	Description
Config DAC	0x8800	Synchronous	Configure the Video DAC

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MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor External Signal Processing

Table 21: TX Manager Host Commands (continued)

TX Manager Host Command	Value	Туре	Description
Set Parallel Mode	0x8801	Synchronous	Configure the Parallel output port



Slave Two-Wire Serial Interface

The two-wire serial interface bus enables read/write access to control and status registers within the MT9V136. This interface is designed to be compatible with the MIPI Alliance Standard for Camera Serial Interface 2 (CSI-2) 1.0, which uses the electrical characteristics and transfer protocols of the two-wire serial interface specification.

The interface protocol uses a master/slave model in which a master controls one or more slave devices. The sensor acts as a slave device. The master generates a clock (SCLK) that is an input to the sensor and used to synchronize transfers.

Data is transferred between the master and the slave on a bidirectional signal (SDATA). SDATA is pulled up to VDD_IO off-chip by a pull-up resistor in the range of 1.5 to $4.7k\Omega$ resistor.

Protocol

Data transfers on the two-wire serial interface bus are performed by a sequence of low-level protocol elements, as follows:

- · a start or restart condition
- · a slave address/data direction byte
- a 16-bit register address
- · an acknowledge or a no-acknowledge bit
- · data bytes
- a stop condition

The bus is idle when both SCLK and SDATA are HIGH. Control of the bus is initiated with a start condition, and the bus is released with a stop condition. Only the master can generate the start and stop conditions.

The SADDR pin is used to select between two different addresses in case of conflict with another device. If SADDR is LOW, the slave address is 0x90; if SADDR is HIGH, the slave address is 0xBA. See Table 22 below.

Table 22: Two-Wire Interface ID Address Switching

SADDR	Two-Wire Interface Address ID	
0	0x90	
1	0xBA	

Start Condition

A start condition is defined as a HIGH-to-LOW transition on SDATA while SCLK is HIGH. At the end of a transfer, the master can generate a start condition without previously generating a stop condition; this is known as a "repeated start" or "restart" condition.

Data Transfer

Data is transferred serially, 8 bits at a time, with the MSB transmitted first. Each byte of data is followed by an acknowledge bit or a no-acknowledge bit. This data transfer mechanism is used for the slave address/data direction byte and for message bytes.

One data bit is transferred during each SCLK clock period. SDATA can change when SCLK is low and must be stable while SCLK is HIGH.

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MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Slave Two-Wire Serial Interface

Slave Address/Data Direction Byte

Bits [7:1] of this byte represent the device slave address and bit [0] indicates the data transfer direction. A "0" in bit [0] indicates a write, and a "1" indicates a read. The default slave addresses used by the MT9V136 are 0x90 (write address) and 0x91 (read address). Alternate slave addresses of 0xBA (write address) and 0xBB (read address) can be selected by asserting the SADDR input signal.

Message Byte

Message bytes are used for sending register addresses and register write data to the slave device and for retrieving register read data. The protocol used is outside the scope of the two-wire serial interface specification.

Acknowledge Bit

Each 8-bit data transfer is followed by an acknowledge bit or a no-acknowledge bit in the SCLK clock period following the data transfer. The transmitter (which is the master when writing, or the slave when reading) releases SDATA. The receiver indicates an acknowledge bit by driving SDATA LOW. As for data transfers, SDATA can change when SCLK is LOW and must be stable while SCLK is HIGH.

No-Acknowledge Bit

The no-acknowledge bit is generated when the receiver does not drive SDATA low during the SCLK clock period following a data transfer. A no-acknowledge bit is used to terminate a read sequence.

Stop Condition

A stop condition is defined as a LOW-to-HIGH transition on SDATA while SCLK is HIGH.



Typical Operation

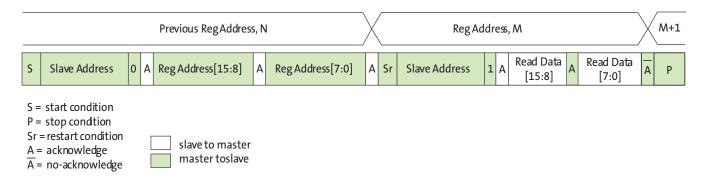
A typical READ or WRITE sequence begins by the master generating a start condition on the bus. After the start condition, the master sends the 8-bit slave address/data direction byte. The last bit indicates whether the request is for a READ or a WRITE, where a "0" indicates a WRITE and a "1" indicates a READ. If the address matches the address of the slave device, the slave device acknowledges receipt of the address by generating an acknowledge bit on the bus.

If the request was a WRITE, the master then transfers the 16-bit register address to which a WRITE will take place. This transfer takes place as two 8-bit sequences and the slave sends an acknowledge bit after each sequence to indicate that the byte has been received. The master will then transfer the 16-bit data, as two 8-bit sequences and the slave sends an acknowledge bit after each sequence to indicate that the byte has been received. The master stops writing by generating a (re)start or stop condition. If the request was a READ, the master sends the 8-bit write slave address/data direction byte and 16-bit register address, just as in the write request. The master then generates a (re)start condition and the 8-bit read slave address/data direction byte, and clocks out the register data, 8 bits at a time. The master generates an acknowledge bit after each 8-bit transfer. The data transfer is stopped when the master sends a no-acknowledge bit.

Single READ from Random Location

Figure 22 shows the typical READ cycle of the host to MT9V136. The first two bytes sent by the host are an internal 16-bit register address. The following 2-byte READ cycle sends the contents of the registers to host.

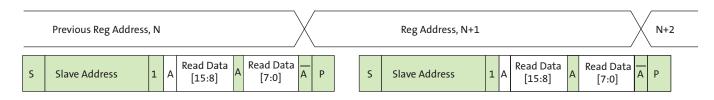
Figure 22: Single READ from Random Location



Single READ from Current Location

Figure 23 shows the single READ cycle without writing the address. The internal address will use the previous address value written to the register.

Figure 23: Single Read from Current Location

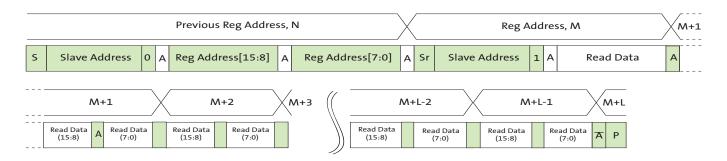




Sequential READ, Start from Random Location

This sequence (Figure 24) starts in the same way as the single READ from random location (Figure 22 on page 42). Instead of generating a no-acknowledge bit after the first byte of data has been transferred, the master generates an acknowledge bit and continues to perform byte READs until "L" bytes have been read.

Figure 24: Sequential READ, Start from Random Location



Sequential READ, Start from Current Location

This sequence (Figure 25) starts in the same way as the single READ from current location (Figure 23). Instead of generating a no-acknowledge bit after the first byte of data has been transferred, the master generates an acknowledge bit and continues to perform byte reads until "L" bytes have been read.

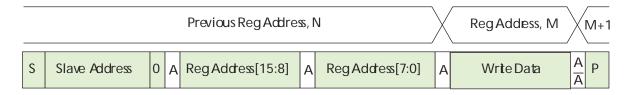
Figure 25: Sequential READ, Start from Current Location



Single Write to Random Location

Figure 26 shows the typical WRITE cycle from the host to the MT9V136. The first 2 bytes indicate a 16-bit address of the internal registers with most-significant byte first. The following 2 bytes indicate the 16-bit data.

Figure 26: Single WRITE to Random Location

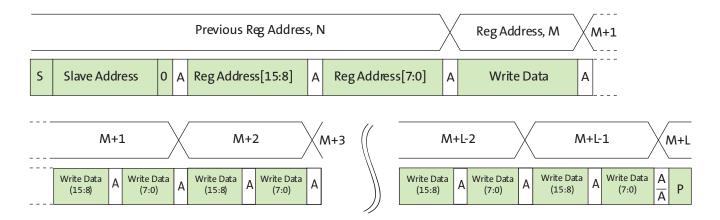




Sequential WRITE, Start at Random Location

This sequence (Figure 27) starts in the same way as the single WRITE to random location (Figure 26). Instead of generating a no-acknowledge bit after the first byte of data has been transferred, the master generates an acknowledge bit and continues to perform byte writes until "L" bytes have been written. The WRITE is terminated by the master generating a stop condition.

Figure 27: Sequential WRITE, Start at Random Location





MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Overlay Capability

Overlay Capability

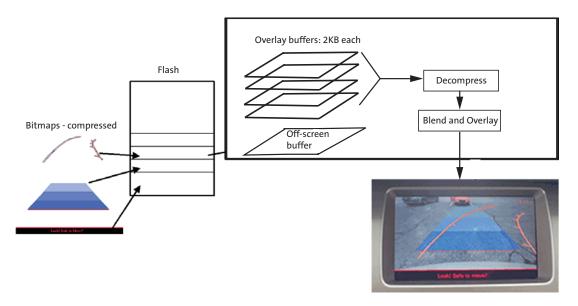
Figure 28 highlights the graphical overlay data flow of the MT9V136. The images are separated to fit into 2KB blocks of memory after compression.

- Up to four overlays may be blended simultaneously
- Overlay size 360 x 480 pixels rendered into a display area of 720 x 480 pixels
- Selectable readout: rotating order is user programmable
- Dynamic movement through predefined overlay images
- Palette of 32 colors out of 64,000 with eight colors per bitmap
- Blend factors may be changed dynamically to achieve smooth transitions

The host commands allow a bitmap to be written piecemeal to a memory buffer through the I^2C , and through the DMA direct from SPI Flash memory. Multiple encoding passes may be required to fit an image into a 2KB block of memory; alternatively, the image can be divided into two or more blocks to make the image fit. Every graphic image may be positioned in an x/y direction and overlap with other graphic images.

The host may load an image at any time. Under control of DMA assist, data are transferred to the off-screen buffer in compressed form. This assures that no display data are corrupted during the replenishment of the four active overlay buffers.

Figure 28: Overlay Data Flow



Note: These images are not actually rendered, but show conceptual objects and object blending.



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Serial Memory Partition

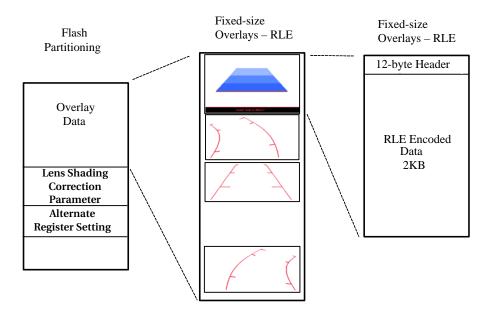
Serial Memory Partition

The contents of the Flash/EEPROM memory partition logically into three blocks (see Figure 29):

- · Memory for overlay data and descriptors
- Memory for register settings, which may be loaded at boot-up
- Firmware extensions or software patches; in addition to the on-chip firmware, extensions reside in this block of memory

These blocks are not necessarily contiguous.

Figure 29: Memory Partitioning



For a complete description of memory organization, refer to the MT9V136 SPI Flash Contents Encoding Specification.

External Memory Speed Requirement

For a 2KB block of overlay to be transferred within a frame time to achieve maximum update rate, the serial memory has to be a certain speed.

Table 23: Transfer Time Estimate

Frame Time SPI Clock		Transfer Time to 2KB	
33.3ms	4.5 MHz	1ms	

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MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Overlay Adjustment

Overlay Adjustment

To ensure a correct position of the overlay to compensate for assembly deviation, the overlay can be adjusted with assistance from the overlay statistics engine:

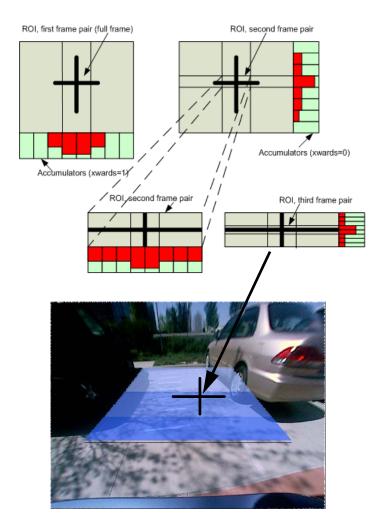
- The overlay statistics engine supports a windowed 8-bin luma histogram, either rowwise (vertical) or column-wise (horizontal).
- The example calibration statistics firmware patch can be used to perform an automatic successive-approximation search of a cross-hair target within the scene.
- On the first frame, the firmware performs a coarse horizontal search, followed by a coarse vertical search in the second frame.
- In subsequent frames, the firmware reduces the region-of-interest of the search to the histogram bins containing the greatest accumulator values, thereby refining the search.
- The resultant X, Y location of the cross-hair target can be used to assign a calibration value of offset selected overlay graphic image positions within the output image.
- The calibration statistics patch also supports a manual mode, which allows the host to access the raw accumulator values directly.

Note: For the overlay calibration feature to work, load the appropriate patch. See Statistics Engine document.



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Overlay Adjustment

Figure 30: Overlay Calibration



The position of the target will be used to determine the calibration value that shifts the X,Y position of adjustable overlay graphics.

The overlay calibration is intended to be applied on a device by device basis "in system," which means after the camera has been installed. Aptina provides basic programming scripts that may reside in the SPI Flash memory to assist in this effort.



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Overlay Character Generator

Overlay Character Generator

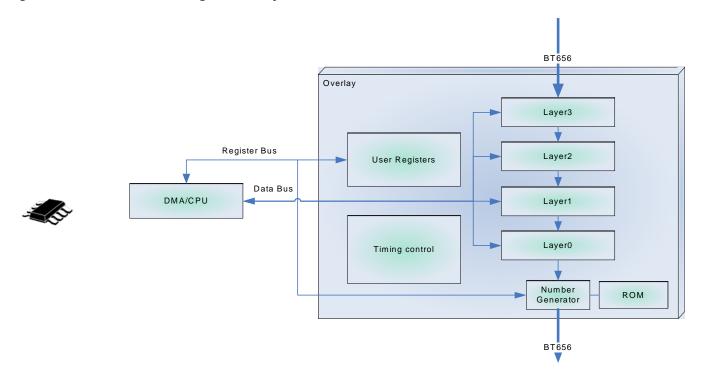
In addition to the four overlay layers, a fifth layer exists for a character generator overlay string.

There are a total of:

- 16 alphanumeric characters available
- 22 characters maximum per line
- 16 x 32 pixels with 1-bit color depth

Any update to the character generator string requires the string to be passed in its entirety with the Host Command. Character strings have their own control properties aside from the Overlay bitmap properties.

Figure 31: Internal Block Diagram Overlay





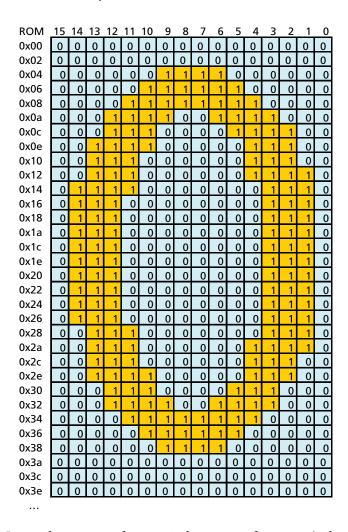
MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Overlay Character Generator

Character Generator

The character generator can be seen as the fifth top layer, but instead of getting the source from RLE data in the memory buffers, it has a predefined 16 characters stored in ROM.

All the characters are 1-bit depth color and are sharing the same YCbCr look up table.

Figure 32: Example of Character Descriptor 0 Stored in ROM



It can show a row of up to 22 characters of 16×32 pixels resolution (32×32 pixels when blended with the BT 656 data).



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Overlay Character Generator

Character Generator Details

Table 24 shows the characters that can be generated.

Table 24: Character Generator Details

Item	Quantity	Description
16-bit character	22	Coder for one of these characters: 0, 1, 2, 3, 4, 5, 6, 7, 8, 9, /, (space), :, –, (comma), (period)
1 bpp color	1	Depth of the bit map is 1 bpp

It is the responsibility of the user to set up proper values in the character positioning to fit them in the same row (that is one of the reasons that 22 is the maximum number of characters).

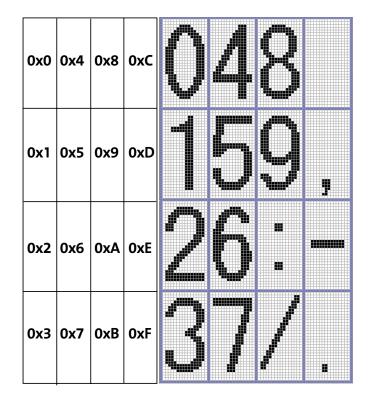
Note: No error is generated if the character row overruns the horizontal or vertical limits of

the frame.

Full Character Set for Overlay

Figure 33 shows all of the characters that can be generated by the MT9V136.

Figure 33: Full Character Set for Overlay





Modes and Timing

This section provides an overview of the typical usage modes and related timing information for the MT9V136.

Composite Video Output

The external pin Dout_LSB0 must be used to configure the device for default NTSC or PAL operation. This and other video configuration settings are available as register settings accessible through the serial interface.

NTSC

Both differential and single-ended connections of the full NTSC format are supported. The differential connection that uses two output lines is used for low noise or long distance applications. The single-ended connection is used for PCB tracks and screened cable where noise is not a concern. The NTSC format has three black lines at the bottom of each image for padding (which most LCDs do not display).

PAL

The PAL format is supported with 576 active image rows.

Single-Ended and Differential Composite Output

The composite output can be operated in a single-ended or differential mode by simply changing the external resistor configuration. For single-ended termination, see Figure 34 on page 52. The differential schematic is shown in Figure 35 on page 53.

Figure 34: Single-Ended Termination

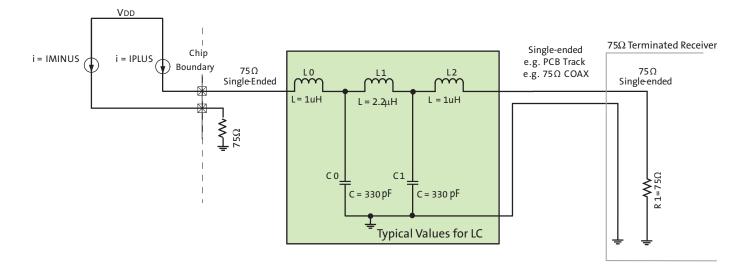
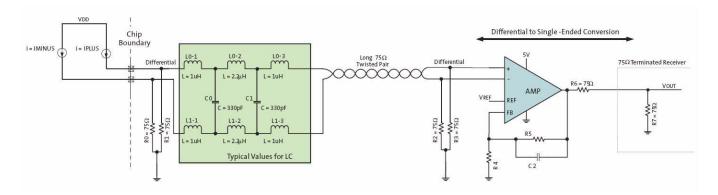




Figure 35: Differential Connection—Grounded Termination



Parallel Output (Douт)

The DOUT[7:0] port supports both progressive and Interlaced mode. Progressive mode (with FV and LV signal) include raw bayer(8 or 10 bit), YCbCr, RGB. Interlaced mode is CCIR656 compliant.

Figure 36 shows the data that is output on the parallel port for CCIR656. Both NTSC and PAL formats are displayed. The blue values in Figure 36 represent NTSC (525/60). The red values represent PAL (625/50).

Figure 36: CCIR656 8-Bit Parallel Interface Format for 525/60 (625/50) Video Systems

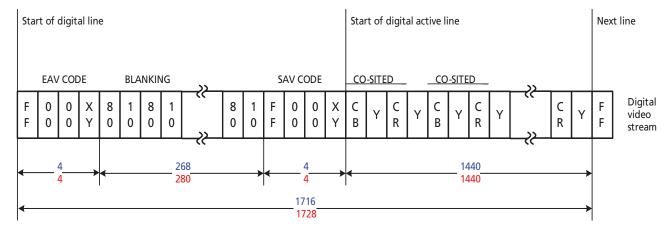


Figure 37 on page 54 shows detailed vertical blanking information for NTSC timing. See Table 25 on page 54 for data on field, vertical blanking, EAV, and SAV states.



Figure 37: Typical CCIR656 Vertical Blanking Intervals for 525/60 Video System

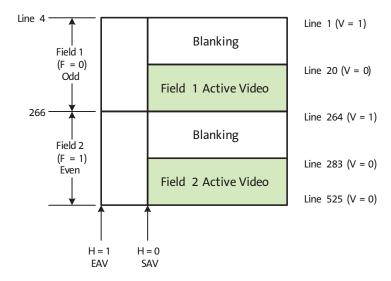


Table 25: Field, Vertical Blanking, EAV, and SAV States 525/60 Video System

Line Number	F	v	H (EAV)	H (SAV)
1–3	1	1	1	0
4–9	0	1	1	0
20–263	0	0	1	0
264–265	0	1	1	0
266–282	1	1	1	0
283–525	1	0	1	0

Figure 38 shows detailed vertical blanking information for PAL timing. See Table 26 on page 55 for data on field, vertical blanking, EAV, and SAV states.



Figure 38: Typical CCIR656 Vertical Blanking Intervals for 625/50 Video System

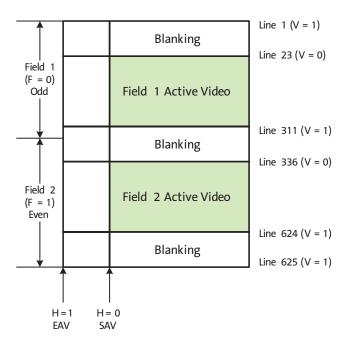


Table 26: Field, Vertical Blanking, EAV, and SAV States for 625/50 Video System

Line Number	F	V	H (EAV)	H (SAV)
1–22	0	1	1	0
23–310	0	0	1	0
311–312	0	1	1	0
313–335	1	1	1	0
336–623	1	0	1	0
624–625	1	1	1	0



Reset and Clocks

Reset

Power-up reset is asserted or de-asserted with the RESET_BAR pin, which is active LOW. In the reset state, all control registers are set to default values. See "Device Configuration" on page 31 for more details on Auto, Host, and Flash configurations.

Soft reset is asserted or de-asserted by the two-wire serial interface program. In soft-reset mode, the two-wire serial interface and the register bus are still running. All control registers are reset using default values.

Clocks

The MT9V136 has two primary clocks:

- A master clock coming from the EXTCLK signal.
- In default mode, a pixel clock (PIXCLK) running at 2 * EXTCLK. In raw Bayer bypass mode, PIXCLK runs at the same frequency as EXTCLK.

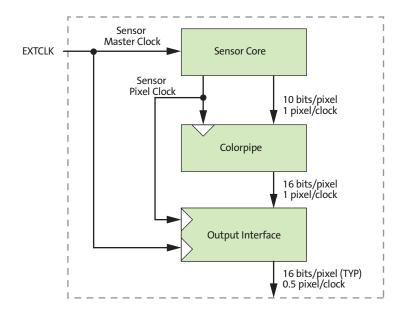
When the MT9V136 operates in sensor stand-alone mode, the image flow pipeline clocks can be shut off to conserve power.

The sensor core is a master in the system. The sensor core frame rate defines the overall image flow pipeline frame rate. Horizontal blanking and vertical blanking are influenced by the sensor configuration, and are also a function of certain image flow pipeline functions. The relationship of the primary clocks is depicted in Figure 39.

The image flow pipeline typically generates up to 16 bits per pixel—for example, YCbCr or 565RGB—but has only an 8-bit port through which to communicate this pixel data.

To generate NTSC or PAL format images, the sensor core requires a 27 MHz clock.

Figure 39: Primary Clock Relationships





Floating Inputs

The following MT9V136 pins cannot be floated:

- SDATA-This pin is bidirectional and should not be floated
- TRST_N

Output Data Ordering

Table 27: Output Data Ordering in DOUT RGB Mode

Mode (Swap Disabled)	Byte	D7	D6	D5	D4	D3	D2	D1	D0
565RGB	First	R7	R6	R5	R4	R3	G7	G6	G5
	Second	G4	G3	G2	В7	B6	B5	B4	В3
555RGB	First	0	R7	R6	R5	R4	R3	G7	G6
	Second	G5	G4	G3	B7	B6	B5	B4	В3
444xRGB	First	R7	R6	R5	R4	G7	G6	G5	G4
	Second	В7	В6	B5	B4	0	0	0	0
x444RGB	First	0	0	0	0	R7	R6	R5	R4
	Second	G7	G6	G5	G4	B7	B6	B5	B4

Note: PIXCLK is 54 MHz when EXTCLK is 27 MHz.

Table 28: Output Data Ordering in Sensor Stand-Alone Mode

Mode	D7	D6	D5	D4	D3	D2	D1	D0	DOUT_LSB1	DOUT_LSB0
10-bit Output	B9	B8	В7	B6	B5	B4	В3	B2	B1	В0

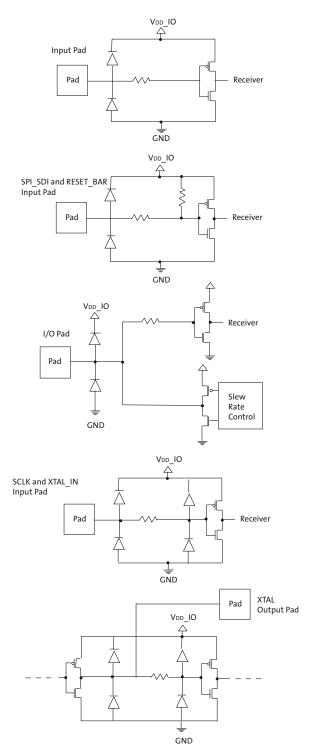
Note: PIXCLK is 27 MHz when EXTCLK is 27 MHz.



I/O Circuitry

Figure 40 illustrates typical circuitry used for each input, output, or I/O pad.

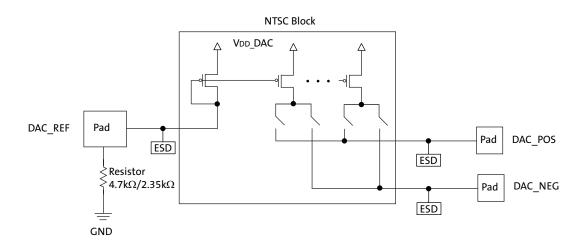
Figure 40: Typical I/O Equivalent Circuits



Note: All I/O circuitry shown above is for reference only. The actual implementation may be different.

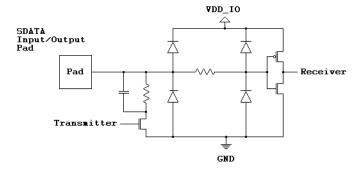


Figure 41: NTSC Block



Note: All I/O circuitry shown above is for reference only. The actual implementation may be different.

Figure 42: Serial Interface





I/O Timing

Digital Output

By default, the MT9V136 launches pixel data, FV, and LV synchronously with the falling edge of PIXCLK. The expectation is that the user captures data, FV, and LV using the rising edge of PIXCLK. The timing diagram is shown in Figure 43.

As an option, the polarity of the PIXCLK can be inverted from the default by programming R0x0016[14].

Figure 43: Digital Output I/O Timing

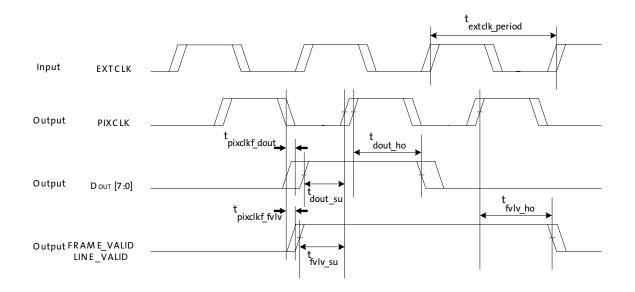


Table 29: Parallel Digital Output I/O Timing

^fEXTCLK = 27 MHz; VDD = 1.8V; VDD_IO = 2.8V; VAA = 2.8V; VAA_PIX = 2.8V; VDD_PLL = 2.8V; VDD_DAC = 2.8V; Default slew rate

Signal	Parameter	Conditions	Min	Тур	Max	Unit
EXTCLK	^f extclk	max ±100 ppm	_	27	_	MHz
	^t extclk_period		_	37	=	ns
	Duty cycle		45	50	55	%
PIXCLK ¹	^f pixclk		_	27	- - 55 - - 55 2 18.5 18.5 2 18.5	MHz
	^t pixclk_period		_	37	=	ns
	Duty cycle		45	50	55 - - 55 2 18.5 18.5 2	%
DATA[7:0]	^t pixclkf_dout		-2	0	2	ns
	^t dout_su		8	-	- - 55 - - 55 2 18.5 18.5 2 18.5	ns
	^t dout_ho		8	-		ns
FV/LV	^t pixclkf_fvlv		-2	0	2	ns
	^t fvlv_su		8	-	18.5	ns
	^t fvlv_ho		8	-	18.5	ns

Note: PIXCLK can be inverted from the default by programming R0x0016[14].



Slew Rate

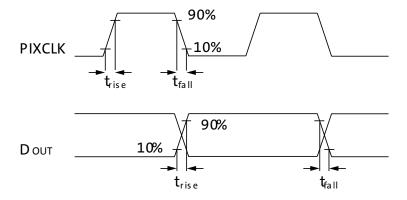
Table 30: Slew Rate for PIXCLK and DOUT

^fEXTCLK = 27 MHz; VDD = 1.8V; VDD_IO = 2.8V; VAA = 2.8V; VAA_PIX = 2.8V;

 $VDD_PLL = 2.8V$; $VDD_DAC = 2.8V$; T = 25°C; CLOAD = 40 pF

	PIXCLK		D оит[7 :0]					
R0x30 [10:8]	Typical Rise Time	Typical Fall Time	R0x30 [2:0]	Typical Rise Time	Typical Fall Time	Unit		
000	6.5	6.3	000	6.5	6.3	ns		
001	4.8	4.6	001	4.8	4.6	ns		
010	3.9	3.8	010	3.9	3.8	ns		
011	3.7	3.7	011	3.7	3.7	ns		
100	3.6	3.6	100	3.6	3.6	ns		
101	3.5	3.5	101	3.5	3.5	ns		
110	3.4	3.4	110	3.4	3.4	ns		
111	3.3	3.3	111	3.3	3.3	ns		

Figure 44: Slew Rate Timing





Configuration Timing

During start-up, the Dout_LSB0, LV and FV are sampled. Setup and hold timing for the RESET_BAR signal with respect to Dout_LSB0, LV, and FV are shown in Figure 45 and Table 31. These signals are sampled once by the on-chip firmware, which yields a long ^tHold time.

Figure 45: Configuration Timing

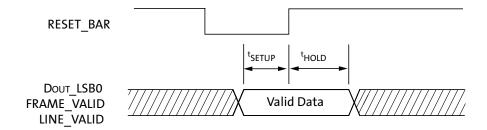
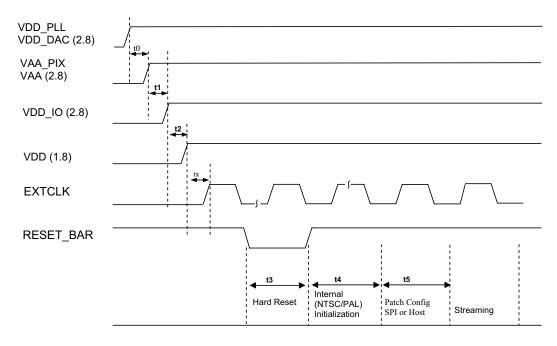


Table 31: Configuration Timing

Signal	Parameter	Min	Тур	Max	Unit
DOUT_LSB0, FRAME_VALID, LINE_VALID	^t SETUP	0			μs
	^t HOLD	50			μs



Figure 46: Power Up Sequence



- Notes: 1. RESET BAR may not exceed VDD IO + 0.3V.
 - 2. The 2.8V plane (VAA, VAA_PIX, VDD_PLL, VDD_DAC, VDD_IO) must remain at a higher voltage than the 1.8V core voltage at all times.

Table 32: Power Up Sequence

Definition	Symbol	Minimum	Typical	Maximum	Unit
VDD_PLL to VAA/VAA_PIX	t0	0	_	_	μS
VAA/VAA_PIX to VDD_IO	t1	0	_	_	μS
VDD_IO to VDD	t2	10	_	_	μS
Xtal settle time	tx	_	30 ¹	_	mS
Hard Reset	t3	10 ²	_	_	Clock cycle
Internal Initialization	t4	50	_	_	mS
Patch Load (SPI or I2C)	t5	_	400 ³	_	mS

Notes:

- 1. Xtal settling time is component-dependent (Xtal, Oscillator, etc) and usually takes about 10mS ~100mS.
- 2. Hard reset time is the minimum time required after power rails are settled. Ten clock cycles are required for the sensor itself, assuming all power rails are settled. In a circuit where Hard reset is performed by the RC circuit, then the RC time must include the all power rail settle time and Xtal
- 3. This is required to load necessary patches via Flash mode (SPI) or Host mode (two-wire serial interface). Loading time varies depending on the number of patches and bus speed.



Figure 47: Power Down Sequence

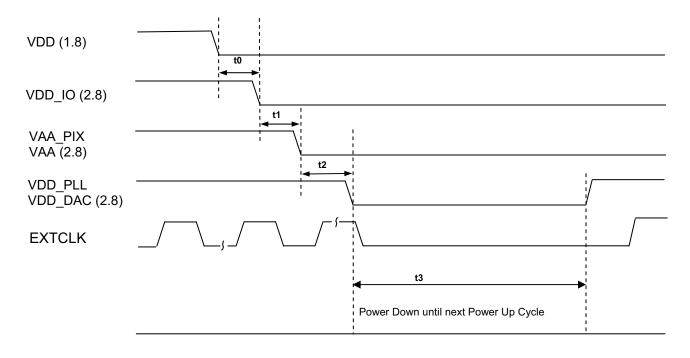


Table 33: Power Down Sequence

Definition	Symbol	Minimum	Typical	Maximum	Unit
VDD to VDD_IO	t0	10	_	_	μS
VDD_IO to VAA/VAA_PIX	t1	0	_	_	μS
VAA/VAA_PIX to VDD_PLL/DAC	t2	0	_	_	μS
Power Down until Next Power Up Time	t3	100 ¹	_	_	ms

(1) t3 is required between power down and next power up time, all decoupling caps from regulators must completely discharged before next power up.

Figure 48: Reset to SPI Access Delay

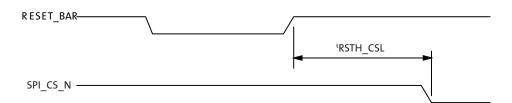




Figure 49: Reset to Serial Access Delay

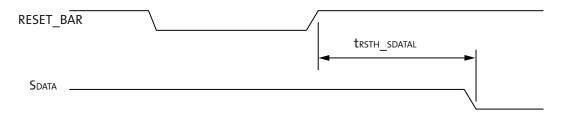


Figure 50: Reset to AE/AWB Image

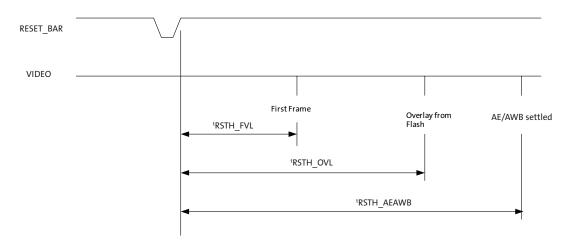


Table 34: RESET_BAR Delay Parameters

Parameter	Name	Condition	Min	Тур	Max	Unit
Power up delay 2.8V to 1.8V			0.1	-	-	ms
RESET_BAR HIGH to SPI_CS_N LOW	tRSTH_CSL		18	_	-	ms
RESET_BAR HIGH to SDATA LOW	trsth_sdatal		1.8	-	-	ms
RESET_BAR HIGH to FRAME_VALID	tRSTH_FVL		235	_	_	ms
RESET_BAR HIGH to first Overlay	tRSTH_OVL		235	-	-	ms
RESET_BAR HIGH to AE/AWB settled	trsth_aeawb		-	400	_	ms



Electrical Specifications

Figure 51: SPI Output Timing

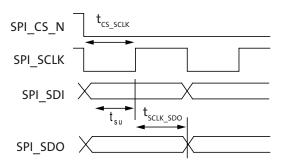


Table 35: SPI Data Setup and Hold Timing

Parameter	Description	Min	Тур	Max	Units
fspi_sclk	SPI_SCLK Frequency	1.6875	4.5	18	MHz
^t su	Setup time	_	_	110	ns
tSCLK_SDO	Hold time			110	ns
tcs_sclk	Delay from falling edge of SPI_CS_N to rising edge of SPI_SCLK	_	230	_	ns



Caution

Stresses greater than those listed in Table 36 may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Table 36: Absolute Maximum Ratings

		Ra	ting	
Symbol	Parameter	Min	Max	Unit
VDD	Digital power (1.8V)	-0.3	2.4	V
VDD_IO	I/O power (2.8v)	-0.3	4	V
VAA	VAA Analog power (2.8V)	-0.3	4	V
VAA_PIX	Pixel array power (2.8v)	-0.3	4	V
VDD_PLL	PLL power (2.8V)	-0.3	4	V
VDD_DAC	DAC power (2.8V)	-0.3	4	V
VIN	DC Input Voltage	-0.3	VDD_IO+0.3	V
Vout	DC Output Voltage	-0.3	VDD_IO+0.3	V
Tstg	Storage temperature	-50	150	°C

Table 37: Electrical Characteristics and Operating Conditions

Parameter ¹	Condition	Min	Тур	Max	Unit
Core digital voltage (VDD)	-	1.7	1.8	1.9	V
IO digital voltage (VDD_IO)	_	2.66	2.8	2.94	V
Video DAC voltage (VDD_DAC)	_	2.66	2.8	2.94	V
PLL Voltage (VDD_PLL)	_	2.66	2.8	2.94	V
Analog voltage (VAA)	_	2.66	2.8	2.94	V
Pixel supply voltage (VAA_PIX)	_	2.66	2.8	2.94	V
Leakage current	EXTCLK: HIGH or LOW			10	μΑ
Imager operating temperature	_	-30		+70	°C
Storage temperature	_	-50		+150	°C

Notes: 1. VAA and VAA_PIX must all be at the same potential to avoid excessive current draw. Care must be taken to avoid excessive noise injection in the analog supplies if all three supplies are tied together.



Table 38: Video DAC Electrical Characteristics—Single-Ended Mode

^fEXTCLK = 27 MHz; VDD = 1.8V; VDD_IO = 2.8V; VAA = 2.8V; VAA_PIX = 2.8V; VDD_PLL = 2.8V; VDD_DAC = 2.8V

Parameter	Condition	Min	Тур	Max	Unit
Resolution		_	10	-	bits
DNL		_	0.2	0.4	bits
INL		_	0.7	3.5	bits
Output local load	Output pad (DAC_POS)	_	75	-	Ω
	Unused output (DAC_NEG)	_	0	-	Ω
Output voltage	Single-ended mode, code 000h	_	.02	-	V
	Single-ended mode, code 3FFh	_	1.30	-	V
Output current	Single-ended mode, code 000h	_	0.26	-	mA
	Single-ended mode, code 3FFh	_	17.33	-	mA
Supply current	Estimate	_	-	25.0	mA
DAC_REF	DAC Reference	_	1.15 +/-0.2	-	V
R DAC_REF	DAC Reference	_	4.7	-	ΚΩ

Table 39: Video DAC Electrical Characteristics—Differential Mode

^fEXTCLK = 27 MHz; VDD = 1.8V; VDD_IO = 2.8V; VAA = 2.8V; VAA_PIX = 2.8V; VDD_PLL = 2.8V; VDD_DAC = 2.8V

Parameter	Condition	Min	Тур	Max	Unit
DNL		-	0.2	0.25	Bits
INL		-	0.8	2.5	Bits
Output local load	Differential mode per pad (DAC_POS and DAC_NEG)	_	37.5	_	Ω
Output voltage	Differential mode, code 000h, pad dacp	_	.02	_	V
	Differential mode, code 000h, pad dacn	-	1.30	_	V
	Differential mode, code 3FFh, pad dacp	-	1.30	-	V
	Differential mode, code 3FFH, pad dacn	_	.02	-	V
Output current	Differential mode, code 000h, pad dacp	-	.53	-	mA
	Differential mode, code 000h, pad dacn	-	34.7	-	mA
	Differential mode, code 3FFh, pad dacp	_	34.7	-	mA
	Differential mode, code 3FFH, pad dacn	_	.53	-	mA
Differential output, midlevel		_	0.65	-	V
Supply current	Estimate	-	-	50	mA
DAC_REF	DAC Reference	-	1.15 +/-0.2		V
R DAC_REF	DAC Reference		2.35		ΚΩ

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MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Electrical Specifications

Table 40: Digital I/O Parameters

T_A = Ambient = 25°C; All supplies at 2.8V

Signal	Parameter	Definitions	Condition	Min	Тур	Max	Unit
All		Load capacitance		1	-	30	pF
Outputs		Output signal slew	2.8V, 30pF load	_	-	-	V/ns
			2.8V, 5pF load	_	-	-	V/ns
	Vон	Output high voltage		_	VDD_IO	-	V
	Vol	Output low voltage		-0.3	-	-	V
	Іон	Output high current	VDD = 2.8V, VOH	_	-	8	mA
			= 2.4V				
	lol	Output low current	VDD = 2.8V, Vol =	-	_	8	mA
			0.4V				
All Inputs	VIH	Input high voltage	VDD = 2.8V	0.7 * VDD_IO	_	VDD_IO + 0.3	٧
	VIL	Input low voltage	VDD = 2.8V	-0.3	_	0.3 * VDD_IO	٧
	lin	Input leakage current		-2	-	2	μΑ
	Signal CAP	Input signal		_	3.5	-	pF
		capacitance					

Notes: 1. All inputs are protected and may be active when All supplies (2.8V and 1.8V) are turned off.



Power Consumption, Operating Mode

Table 41: Power Consumption – Condition 1

^fEXTCLK = 27 MHz; VDD = 1.8V; VDD _IO = 2.8V; VAA =2.8V; VAA_PIX=2.8V; VDD PLL = 2.8V; VDD DAC = 2.8V

Power Plane	Supply	Condition 1	Typ Power	Max Power	Unit
VDD	1.8		140.4	162	mW
VDD_IO	2.8	Parallel off	4.2	8.4	mW
VAA	2.8		89.6	112	mW
VAA_PIX	2.8		1.96	5.04	mW
VDD_DAC	2.8	Single 75(1)	39.2	44.8	mW
VDD_PLL	2.8		13.44	16.8	mW
		Total	288.8	349.04	mW

Analog output uses single-ended mode: DAC_Pos = 75Ω , DAC_Neg = open, parallel output is disabled.

Table 42: Power Consumption – Condition 2

^fEXTCLK = 27 MHz; VDD = 1.8V; VDD _IO = 2.8V; VAA =2.8V; VAA_PIX=2.8V; VDD PLL = 2.8V; VDD DAC = 2.8V

Power Plane	Supply	Condition 2	Typ Power	Max Power	Unit
Vdd	1.8		140.4	162	mW
Vdd_IO	2.8	Parallel on	42	50.4	mW
VAA	2.8		89.6	112	mW
VAA_PIX	2.8		1.96	5.04	mW
VDD_DAC	2.8	Single 75(1)	39.2	44.8	mW
VDD_PLL	2.8		13.44	16.8	mW
		Total	326.6	391.04	mW

Analog output uses single-ended mode: DAC_Pos = 75Ω , DAC_Neg = open, parallel output is enabled.



NTSC Signal Parameters

Table 43: **NTSC Signal Parameters**

^fEXTCLK = 27 MHz; Vdd = 1.8V; Vdd_IO = 2.8V; VAA = 2.8V; VAA_PIX = 2.8V;

VDD PLL = 2.8V; VDD DAC = 2.8V

Parameter	Conditions	Min	Тур	Max	Units	Notes
Line Frequency		15734.25	15734.27	15734.28	Hz	
Field Frequency		59.94	59.94	59.94	Hz	
Sync Rise Time		148	148	148	ns	
Sync Fall Time		148	148	148	ns	
Sync Width		4.74	4.74	4.74	μs	
Sync Level		37	39.9	43	IRE	2, 4
Burst Level		37	39.7	43	IRE	2, 4
Sync to Setup (with pedestal off)		9.44	9.44	9.44	μs	
Sync to Burst Start		5.33	5.33	5.33	μs	
Front Porch		1.33	1.33	1.33	μs	
Black Level		6.5	7.5	8.5	IRE	1, 2, 4
White Level		90	100	110	IRE	1, 2, 3, 4

- Notes: 1. Black and white levels are referenced to the blanking level.
 - 2. NTSC convention standardized by the IRE (1 IRE = 7.14mV).
 - 3. Encoder contrast setting R0x011 = R0x001 = 0.
 - 4. DAC ref = $2.8k\Omega$, load = 37.5Ω .

Figure 52: Video Timing

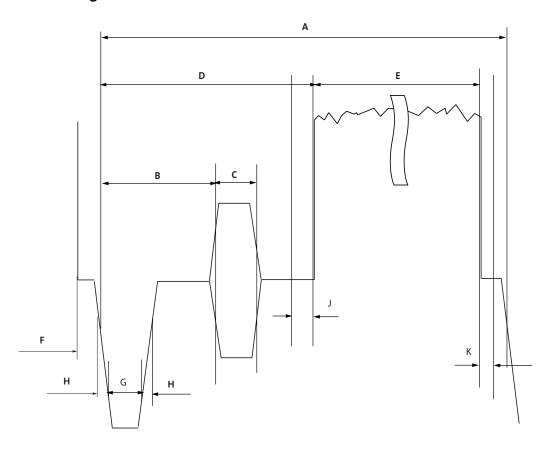


Table 44: Video Timing

	Signal	NTSC 27 MHz	PAL 27 MHz	Units
Α	H Period	1716	1728	Clocks
В	Hsync to burst	144	153	Clocks
С	burst	63	66	Clocks
D	Hsync to Signal	255	279	Clocks
E	Video Signal	1423	1413	Clocks
F	Front	36	39	Clocks
G	Hsync Period	128	128	Clocks
Н	Sync rising/falling edge	4	4	Clocks
J	Back overscan (BOS)	9	14	Clocks
K	Front overscan (FOS)	8	13	Clocks



Figure 53: Equivalent Pulse

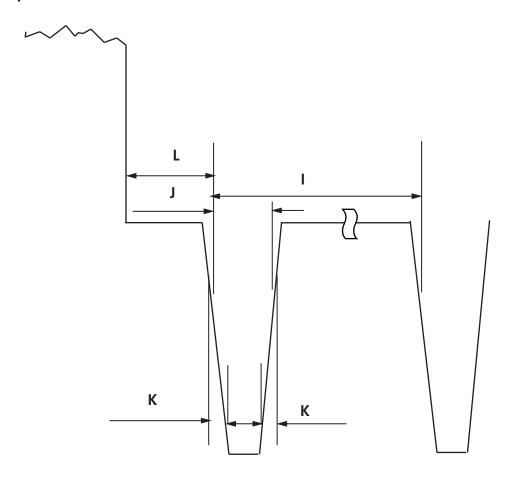


Table 45: Equivalent Pulse

	Signal	NTSC 27 MHz	PAL 27 MHz	Units
I	H/2 Period	858	864	Clocks
J	Pulse width	64	64	Clocks
K	Pulse rising/falling edge	4	4	Clocks
L	Signal to pulse	38	41	Clocks



Figure 54: V Pulse

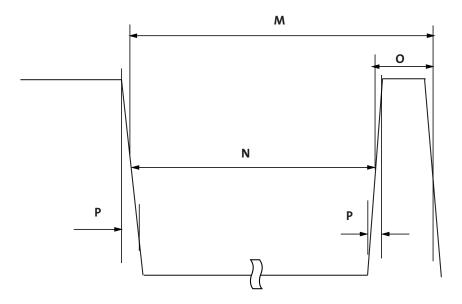


Table 46: V Pulse

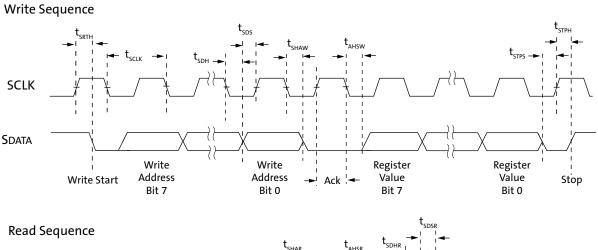
	Signal	NTSC 27 MHz	PAL 27 MHz	Units
M	H/2 Period	858	864	Clocks
N	Pulse width	730	736	Clocks
0	V pulse interval	128	128	Clocks
Р	Pulse rising/falling edge	4	4	Clocks

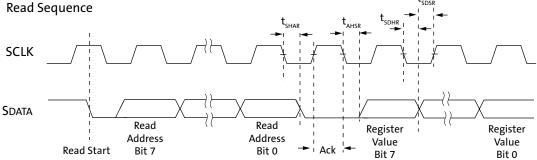


Two-Wire Serial Bus Timing

Figure 55 and Table 47 on page 76 describe the timing for the two-wire serial interface.

Figure 55: Two-Wire Serial Bus Timing Parameters





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Table 47: Two-Wire Serial Bus Characteristics

 f EXTCLK = 27 MHz; VDD = 1.8V; VDD_IO = 2.8V; VAA = 2.8V; VAA_PIX = 2.8V; VDD_PLL = 2.8V; VDD_DAC = 2.8V; TA = 25 $^{\circ}$ C

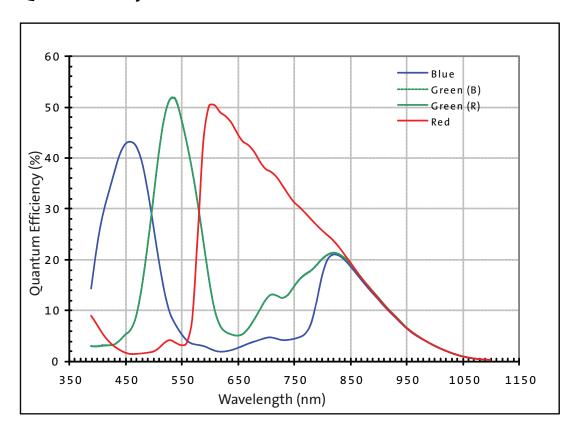
Symbol	Parameter	Conditions	Min	Тур	Max	Unit	Note
^f SCLK	Serial interface input clock frequency		100	-	400	kHz	
^t SCLK	Serial interface input clock period		2.5	_	10	μs	Master clock cycle units or PLL cycles if enabled
	SCLK duty cycle		40	50	60	%	
^t SRTH	Start hold time	Write/Read	0.3	_	_	μs	Master clock cycle units or PLL cycles if enabled
^t SDH	SDATA hold	Write	0.3	_	_	μѕ	Master clock cycle units or PLL cycles if enabled
^t SDS	SDATA setup	Write	0.3	_	_	μs	Master clock cycle units or PLL cycles if enabled
^t SHAW	SDATA hold to ack	Write	0.15	_	0.75	μѕ	Master clock cycle units or PLL cycles if enabled
^t AHSW	Ack hold to SDATA	Write	0.3	_	_	μs	Master clock cycle units or PLL cycles if enabled
^t STPS	Stop setup time	Write/Read	0.3	_	_	μs	Master clock cycle units or PLL cycles if enabled
^t STPH	Stop hold time	Write/Read	0.6	_	_	μs	Master clock cycle units or PLL cycles if enabled
^t SHAR	SDATA hold to ack	Read	0.15	_	0.75	μs	Master clock cycle units or PLL cycles if enabled
^t AHSR	Ack hold to SDATA	Read	0.15	_	1	μs	Master clock cycle units or PLL cycles if enabled
^t SDHR	SDATA hold	Read	0.3	_	_	μs	Master clock cycle units or PLL cycles if enabled
^t SDSR	SDATA setup	Read	0.3	_	_	μs	Master clock cycle units or PLL cycles if enabled
C _{IN_SI}	Serial interface input pin capacitance		-	_	3.3	pF	
C _{LOAD SD}	SDATA max load capacitance		_	-	30	pF	
R _{SD}	SDATA pull-up resistor			1.5		ΚΩ	



MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Spectral Characteristics

Spectral Characteristics

Figure 56: Quantum Efficiency

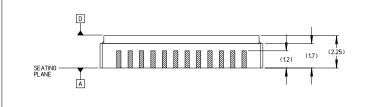


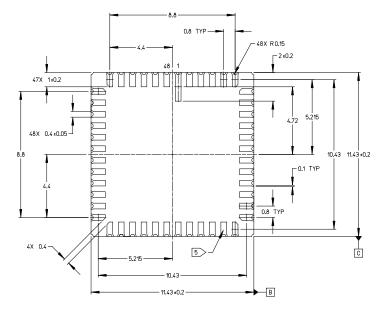
MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image SensorPackage and Die Dimensions

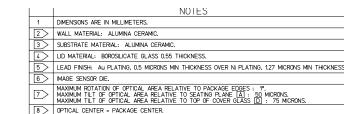
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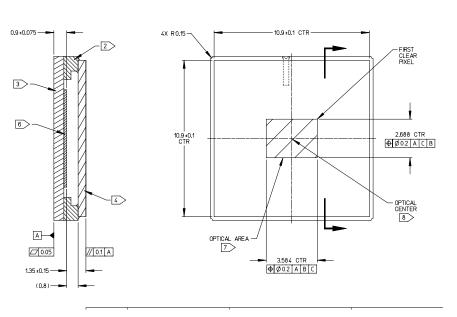
Package and Die Dimensions

Figure 57: 48-Pin CLCC Package Outline Drawing









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MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Revision History

Revision History	
Rev.D	5/25/10
	Updated package pitch number.
Rev. C	4/5/10
100.0	Updated title
	Updated "Features" on page 1
	Updated Table 1, "Key Parameters," on page 1
	Updated Table 3, "Available Part Numbers," on page 3
	Updated "On-Chip Overlay Generator" on page 3
	Updated "General Description" on page 9
	 Moved register tables to a separate document, "MT9V136 Register and Variable Reference"
	Updated Table 4, "Pin Descriptions," on page 13
	Updated Figure 4: "Pin Assignments," on page 15
	Updated Table 5, "Reset/Default State of Interfaces," on page 15
	Updated "Pixel Array Structure" on page 17
	Deleted first sentence of 2nd paragraph of "Sensor Pixel Array" on page 19
	Updated Figure 8: "Sensor Pixel Array," on page 19
	• Updated Figure 9: "Pixel Color Pattern Detail (top right corner)," on page 19
	• Updated Figure 11: "Color Pipeline," on page 21
	Updated "Positional Gain Adjustments (PGA)" on page 24
	Updated "Device Configuration" on page 31
	 Updated "Flash Configuration Mode" on page 32
	 Updated "Host Configuration" on page 32
	 Updated "Power Sequence" on page 33
	 Updated Table 13, "SPI Flash Devices," on page 34
	 Updated "Command Flow" on page 36
	 Updated "Set Parallel Mode - Normal (Overlay i656)" on page 37
	 Updated "Summary of Host Commands" on page 37, including
	 Table 16, "System Manager Commands," on page 37
	 Table 17, "Overlay Host Commands," on page 37
	 Table 18, "GPIO Host Commands," on page 38
	 Table 19, "Flash Manager Host Commands," on page 38
	 Table 20, "Sequencer Host Commands," on page 38
	 Table 21, "TX Manager Host Commands," on page 38
	Updated "Overlay Capability" on page 45
	Updated "Overlay Adjustment" on page 47
	 Changed "Overlay Number Generator" heading to "Overlay Character Generator" on page 49
	Updated "Modes and Timing" on page 52
	 Updated and moved the section "I/O Circuitry" on page 58
	 Updated Table 29, "Parallel Digital Output I/O Timing," on page 60
	 Replaced section on RESET_N Timing with "Configuration Timing" on page 62
	Updated "Electrical Specifications" on page 66

• Updated to Production status

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MT9V136: 1/4-Inch Color CMOS NTSC/PAL Digital Image Sensor Revision History

- Updated "Features" on page 1
- Updated Table 1, "Key Parameters," on page 1 and Table 2, "Key Parameters (continued)," on page 2
- Updated "Available Part Numbers" on page 3
- Updated Table 4, "Pin Descriptions," on page 12
- Updated "Pixel Array Structure" on page 17
- Updated "Sensor Pixel Array" on page 18
- Updated "Positional Gain Adjustments (PGA)" on page 23
- Updated "Usage Modes" on page 28
- Moved register tables and section on "How to Access Registers and Variables" to separate document
- Updated "Command Flow" on page 35
- Updated Figure 26: "Single Write to Random Location," on page 42
- Updated Table 21, "TX Manager Host Commands," on page 37
- Updated "Overlay Capability" on page 44
- Updated "Overlay Adjustment" on page 46
- Changed "Overlay Number Generator" to "Overlay Character Generator," on page 48
- Added Table 36, "Absolute Maximum Ratings," on page 66

Initial release

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This data sheet contains minimum and maximum limits specified over the power supply and temperature range set forth herein. Although considered final, these specifications are subject to change, as further product development and data characterization sometimes occur.